

A Global Leading IoT Terminals And Wireless Data Solutions Provider

# **MA922 Hardware Design Manual**

Controlled version: V 1.02 Release date: 2024.6





## IMPORTANT NOTICE

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## **EU Conformity Statement**



Hereby, [MeiG Smart Technology Co.,Ltd] declares that the radio equipment type [MA922] is in compliance with Directive 2014/53/EU.

#### RF Exposure Information

This device has been tested and meets applicable limits for Radio Frequency (RF) exposure. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

## FCC Statement:

Please take attention that changes or modification not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following t wo conditions:

(1) This device may not cause harmful interference, and



(2) This device must accept any interference received, including interference that may cau se undesired operation.

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

(1) Operational use conditions

Module has professional users use condition limitations, Host product manufacturer please ensure giving such warning like "Product is limited to professional users use" in your product's instruction.

(2) Antenna used

Antenna Type: External antenna

Max. Gain: 5.29dBi

(3) Labelling Instruction for Host Product Integrator

Please notice that if the FCC identification number is not visible when the module is install ed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. For FCC, this exterior label sho uld follow "Contains FCC ID: 2APJ4-MA922". In accordance with FCC KDB guidance 78474 8 Labeling Guidelines.

§15.19 and RSS-Gen Labelling requirements shall be complied on end user device. Labell ing rules for special device, please refer to §2.925, § 15.19 (a)(5) and relevant KDB public ations. For E-label, please refer to §2.935.

(4) Installation Notice to Host Product Manufacturer

The OEM integrator is responsible for ensuring that the end-user has no manual instruction to remove or install module.

The module is limited to installation in mobile application, a separate approval is required f or all other operating configurations, including portable configurations with respect to §2.10 93 and difference antenna configurations.

(5) Antenna Change Notice to Host manufacturer

If you desire to increase antenna gain and either change antenna type or use same antenn a type certified, a Class II permissive change application is required to be filed by us, or yo u (host manufacturer) can take responsibility through the change in FCC ID and IC ID (ne w application) procedure followed by a Class II permissive change application.

(6) FCC other Parts, Part 15B Compliance Requirements for Host product manufacturer

This modular transmitter is only FCC authorized for the specific rule parts listed on our grant, host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification.



Host manufacturer in any case shall ensure host product which is installed and operating with the module is in compliant with Part 15B requirements.

Please note that For a Class B or Class A digital device or peripheral, the instructions furni shed the user manual of the end-user product shall include statement set out in §15.105 In formation to the user or such similar statement and place it in a prominent location in the text of host product manual. Original texts as following:

## For Class B

Note: This equipment has been tested and found to comply with the limits for a Class B dig ital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide rea sonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in a ccordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- —Reorient or relocate the receiving antenna.
- —Increase the separation between the equipment and receiver.
- —Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- —Consult the dealer or an experienced radio/TV technician for help.

#### For Class A

Note: This equipment has been tested and found to comply with the limits for a Class A dig ital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide rea sonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency en ergy and, if not installed and used in accordance with the instruction manual, may cause h armful interference to radio communications. Operation of this equipment in a residential a rea is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.



# **Revision History**

Serial Number	Revision	Date	Description
1	V1.00	2023-11	First edition
2	V1.01	2024-4	1. sheet74, 3.14_SPI: correct SPI I/O type to DIO, add SPI Master and Slave mode Description 2. 3.3 pin Description: correct SPI I/O type to DIO 3. Sheet77, 3.15_RGMII: correct RGMII layout line Tx bus and Rx bus traces at least 2 times trace width. 4. Sheet65, 3.9_I2C\I2S: reflash I2C/I2SDescription, add I2C1&I2S1 default for Audio codec 5. Sheet 56, 3.4.2 Reduce Voltage Drop:pitcure6,correct DC_IN to DC_3.8V
3	V1.02	2024-6	1. Reflash 2.2 main performance about PCI Express Base Specification Revision 2. Reflash 3.11 PCIE Interfaces Compliant with PCI Express Base Specification Revision 3. Reflash 3.11 PCIE Interfaces, about PCIE data rate 4. Reflash 3.11 PCIE Interfaces, about PCIE AC coupling capacitance change to 220nF. 5. Reflash 3.11 PCIE Interfaces, about PCIE Bus length change to 300mm. 6. Reflash 5.3 module power consumption, add power off leakage current data and Deep sleep mode minimum current data. 7. Reflash IMPORTANT NOTICE, add EU Conformity Statement and FCC Statement

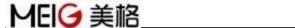


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# 1. Introduction

This document introduces MA922 and the air interface and hardware interface between module and customer application.

This document can help customers quickly understand MA922 module interface specifications, electrical characteristics, mechanical specifications and related product information. With the help of this document, combined with our application manual and user guide, customers can quickly apply the MA922 module to wireless applications.

MA922 wireless module is a broadband wireless terminal product suitable for TDD-LTE/FDD-LTEG/5GNR multiple network standards and multiple frequency bands.

Except wireless data access, MA922 can provide functions such as voice and SMS, and can be widely used in M2M fields, such as OTT, CPE, routers, data cards, tablet computers, security and industrial-grade PDAs.



# 1.1 Safety Instruction

You can ensure personal safety and help protect your product and work environment from potential damage by following the following safety principles:

Driving safety first! When you are driving, do not use a handheld mobile terminal unless it has a hands-free function. Please stop and call again!
Please turn off your mobile terminal device before boarding. The wireless function of the mobile terminal is prohibited to be turned on on the aircraft to prevent interference with the aircraft communication system. Ignoring this reminder may lead to flight safety or even breaking the law.
In hospitals or health care facilities, pay attention to whether there are restrictions on the use of mobile terminal devices. RF interference can cause medical equipment to malfunction, so mobile terminal equipment may need to be turned off.
The mobile terminal device cannot be effectively connected under any circumstances, there is no call charge or the SIM is invalid in the mobile device. When you encounter the above situation in an emergency, please remember to make an emergency call, and make sure your device is turned on and in an area with sufficient signal strength.
Your mobile terminal device receives and transmits radio frequency signals when it is turned on. Radio frequency interference may occur when near televisions, radios, computers or other electronic equipment.
Keep mobile devices away from flammable gases. When you are near gas stations, oil depots, chemical plants or explosive workplaces, please turn off the mobile terminal equipment. Operating electronic equipment in any potentially explosive location is a safety hazard.



## 1.2 Document Purpose

This file elaborates the basic functions, main features, hardware interface and its use method, structural characteristics, power consumption index and electrical characteristics of MA922 wireless module in detail, and guides users to apply MA922 module to various application terminals.

## 1.3 Content

This article is divided into the following parts:

- Chapter 1 mainly introduces security instructions, document purpose, revision history, etc.;
- ☐ Chapter 2 describes the basic functions and main features of MA922 wireless module;
- Chapter 3 describes the functions, characteristics and usage of each hardware interface in detail:
- Chapter 4 related information and precautions of antenna interfaces;
- Chapter 5 describes MA922 electrical characteristics in detail:
- ☐ Chapter 6 describes in detail the features and precautions of MA922 structure;
- ☐ Chapter 7 describes in detail MA922 precautions in storage and production;
- Chapter 8 Appendix A Reference Documents and Term Abbreviations;



# 2. Product Overview

## 2.1 Basic Description

The MA922 is a 5GNR, Sub-6 GHz wireless communication module with 5GNR, LTE-FDD, LTE-TDD, DC-HSDPA, HSPA+, HSDPA, HSUPA, WCDMA, EDGE and GPRS network functions. It also has single/dual frequency, GNSS and voice capabilities for specific applications.

The MA922 module supports the following frequency bands.

#### **FCC**

- 5GNR: n2/n5/n12/n25/n41/n66/n71/n77/n78
- □ TDD-LTE: B41
- ☐ FDD-LTE: B2/B4/B5/B7/B12/B13/B14/B17/B25/B26/B30RX/B66/B71
- ☐ WCDMA: B2/B4/B5
- ☐ GNSS (optional)
- ☐ Single-frequency GNSS: L1 (GPS, GLONASS, BDS, Galileo, QZSS)
- ☐ Dual-frequency GNSS: L1 + L5 (GPS, GLONASS, BDS, Galileo, QZSS)

Module size: 54.5mm x 53.0mm x 3.45mm, which can basically cover all application scenarios of the car. The module is designed to meet the demanding requirements of automotive applications and other harsh conditions, providing premium solutions for safe and reliable connected car solutions and autonomous driving solutions. It is widely used in T-Boxes, TCU, ADAS, C-V2X (V2V, V21, V2P), OBU, RSU, and other automotive/traffic systems.

## 2.2 Main Performance

The following table shows the performance of MA922 module.

Table 1 List of main features of module

MeiG Smart Technology Co., Ltd.



17に10天地	MA922 Hardware Design Manua
Parameter	Description
	VBAT_BB/VBAT_RF:
Power	$\square$ Supply voltage range: 3.5 V $\sim$ 4.2 V
1 ower	☐ Typical supply voltage: 3.8V
	VPH_5V_V2X
	$\square$ Supply voltage range: 4.75 $\sim$ 5.25 V
	☐ Typical supply voltage: 5.0V
	Class 2 (26 dBm +1/-2 dB) for 5G NR TDD HPUE
	n41/n77/n78/n79 bands
Transmit power	Class 3 (23 dBm ±2 dB) for 5G NR FDD bands
	Class 3 (23 dBm ±2 dB) for LTE bands
	Class 3 (23 dBm ±2 dB) for WCDMA bands
	Class 4 (33 dBm ±2 dB) for EGSM900
	Class 1 (30 dBm ±2 dB) for DCS1800
	Class E2 (27 dBm ±3 dB) for EGSM900 8-PSK
	Class E2 (26 dBm ±3 dB) for DCS1800 8-PSK
	Support 3GPP Rel-16
	Support modulations:
	Uplink: π/2-BPSK, QPSK, 16QAM, 64QAM and 256QAM
5G NR Features	Downlink: QPSK, 16QAM, 64QAM and 256QAM
	Support 4 x 4 MIMO for MHB bands in DL direction
	Support SCS 15 kHz (FDD) and 30 kHz (TDD)
	Support Option 3x, 3a and Option 2
	Support SA and NSA
	Max. transmission data rates:
	NSA: 2.4 Gbps (DL)/550 Mbps (UL)
	SA: 2.0 Gbps (DL)/450 Mbps (UL)
	Support up to 4CA Cat 16
	Support 1.4/3/5/10/15/20 MHz RF bandwidth
LTE Features	Support 4 × 4 MIMO in DL direction
	Support modulation mode:
	Uplink: QPSK, 16QAM, 64QAM, 256QAM*
	Downlink: QPSK, 16QAM, 64QAM, 256QAM
	LTE-FDD: Max. 1.2 Gbps (DL)/100 Mbps (UL)
	LTE-TDD: Max. 1.0 Gbps (DL)/60 Mbps (UL)
	GPRS:
	Support GPRS multi-slot class 33 (33 by default)
	Coding scheme: CS 1–4
GSM Features	Max. 107 kbps (DL)/85.6 kbps (UL)
	EDGE:
	Support EDGE multi-slot class 33 (33 by default)
	Support GMSK and 8-PSK for different MCS (Modulation
	and Coding
	Scheme)
	Downlink coding schemes: MCS 1–9
	Uplink coding schemes: MCS 1–9
	☐ Max. 296 kbps (DL)/236.8 kbps (UL)



一 美心	MA922 Hardware Design Manua		
	Support GPS, GLONASS, BDS, Galileo, QZSS		
GNSS Features	Support dual-frequency GNSS (L1 + L5)		
	Agreement: NMEA 0183		
	Update rate: 1 Hz by default, max. up to 10 Hz		
C-V2X Features	Support C-V2X TDD up to 30 Mbps (Tx)/30 Mbps (Rx)		
0-VZX i catales	Support globally unified ITS @ 5.9 GHz		
Network protocol characteristics	TCPIP/UDP/HTTP(S)/MQTT/FTP/SSL/OneNet		
	Text and PDU mode		
Short message (SMS)	Point-to-point MO and MT		
	Cell broadcast		
USIM Card interface	Support U/SIM1(2) card: 1.8V and 3V		
	Default for external codec configuration		
I2S interface	☐ Supports the master-slave mode		
	Default for external Codec and IMUs		
I2C interface	☐ Complies with I2C 3.0 bus specifications		
	Multiple host modes are not supported		
	Can be used for audio use, requires an external Codec		
	chip		
PCM interface	Default for Bluetooth audio data transmission		
1 GW internace	Supports 16-bit data format		
	Supports To-bit data format     Supports long frame synchronization and short frame		
	synchronization		
	☐ Supports the master-slave mode		
	Conforms to the USB 3.1 Gen 2 and USB 2.0		
	specifications, the maximum theoretical transfer rate of USB		
	3.1 can reach 10Gbps, and the maximum theoretical transfer		
	rate of USB 2.0 can reach 480Mbps		
USB interface	USB 2.0 and USB 3.1 are used for AT command		
	communication, data transfer, software debugging, and GNSS		
	NMEA statement output		
	☐ The firmware can be upgraded by USB 2.0 or USB3.1 ☐ When USB 2.0 and USB 3.1 are connected to the same		
	host, the USB 3.1 port is used by default		
	USB driver: Support Windows 7/8/8.1/10/11, Linux		
	2.6-5.18 and Android 4.x-12.x		
	UART1:		
	Used for AT command and data transmission		
	For data transmission		
	Baud rate up to 921600 bps, the default is 115200 bps		
Serial port	□ Support RTS and CTS hardware flow control		
	Bluetooth UART:		
	☐ For data transmission; The default value is Bluetooth		
	Baud rate up to 921600 bps, the default is 115200 bps		
	☐ Support RTS and CTS hardware flow control		
	Debug UART:		
	☐ For Linux console and log output		
	☐ The default baud rate is 115200bps		
	1 The deladit badd rate is 1132000ps		



	MA922 Hardware Design Manua				
SDIO interface	□ Comply with SD3.0 protocol				
	□ Supports eMMC and SD card or DSRC				
SPI interface	☐ Two SPI interfaces are supported by default				
	☐ Clock frequency Upper limit: 50MHz				
RGMII interface	2.5Gbps Ethernet connection is supported				
USXGMI interface	☐ USB interface				
WLAN and Bluetooth interface	☐ WLAN supports the PCle (Gen 3) interface				
	☐ Supports Bluetooth UART and PCM interfaces				
	☐ Supports two groups of PCIE ports				
	☐ Conforms to PCI Express Base Specification Revision 3.0				
PCIe Interface	(PCIE1&2) and Revision 4.0 (PCIE1)				
	☐ Supports one set of 2-lane Pcles with a theoretical				
	maximum speed of 8GT /s x 1-lane				
	☐ The WLAN function is used by default				
	☐ Supports one group of 1-lan PCle with a theoretical				
	maximum rate of 8GT /s				
	☐ GSM: HR/FR/EFR/AMR/AMR-WB				
Audio function	□ WCDMA: AMR/AMR-WB				
	□ LTE: AMR/AMR-WB				
	Supports echo cancellation and noise suppression				
AT command	☐ Comply with 3GPP TS 27.007, 27.005, and add MeiG AT				
	command				
	☐ Main antenna interface (ANT_MAIN)				
	RX- Hierarchical Antenna Interface (ANT_DIV)				
Antenna interface	☐ Two MIMO antenna interfaces				
	(ANT_MIMO3,ANT_MIMO4)				
	☐ Two C-V2X interfaces				
	(ANT_CV2X_TRX0,ANT_CV2X_TRX1)				
	One GNSS antenna interface (ANT_GNSS)				
Physical characteristics	☐ Dimensions: (54.5±0.2)×(53.0±0.2)×(3.45±0.2)mm				
	□ Weight: TBD				
Temperature range	□ Normal working temperature: -35°C ~ +75°C				
· ·····p · · · · · · · · · · · · · · ·	☐ Extended temperature: -40°C ~ +85°C				
	☐ Storage temperature: -40°C ~ +95°C				
Software upgrade	□ USB 2.0/USB 3.1				
	□ DFOTA				
RoHS	All devices are fully compliant with EU RoHS standards				
Ambient humidity	□ 5%~95%				
Interface	🛮 524 LGA Pins				
	□ Power interface				
	☐ USIM/SIM card interface (support 3V, 1.8V)				
LGA function interface	□ I2S interface				
	□ I2C interface				
	PCM interface				
	USB2.0 and USB3.1 interfaces				
	□ UART interface				
	□ SDIO interface				



「「「」」 美脂	MA922 Hardware Design Manua
	□ SPI interface
	□ RGMII&SGMII&USXGMII interface
	□ PCIe interface (can be used for external WLAN&BT
	modules)
	□ ADC interface
	☐ Hardware boot and reset interface
	□ Dormancy indication interface
	☐ GPIO port
	□ USB_BOOT Indicates the interface
·	<u> </u>



# 2.3 Functional Block Diagram

The following is the block diagram of MA922, explaining its main function part.

- Power management unit
- Baseband unit
- Built-in memory
- RF part
- Peripheral interface

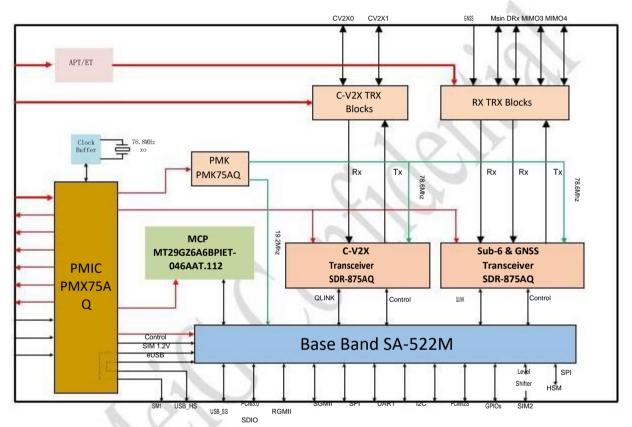


Figure 1 Functional block diagram



## 2.4 Evaluation Board

For testing and use of MA922, MeiG provides a set of evaluation boards, including USB cables, antennas, and other peripherals.

Please refer to the "MA922\_USB\_EVB User Manual" for the specific usage of the evaluation board.





# 3. Application Interface

# 3.1 Basic Description

MA922 adopts 80 pin LCC+64 pin LGA package, providing the following functional interfaces:

- Power interface
- USIM/SIM interface (support 3V, 1.8V) \*2
- I2S port \*2
- I2C interface \*2
- PCM interface
- □ USB2.0 and USB3.1 interfaces
- □ UART interface \*5
- □ SDIO Interface \*2
- ☐ SPI interface \*2
- ☐ RGMII&SGMII&USXGMII interface
- ☐ PCIe port \*2 (can be used for external WLAN&BT modules)
- ADC interface \*3
- Hardware boot and reset interface
- ☐ Dormancy indication interface
- ☐ GPIO port \*15
- □ USB\_BOOT Indicates the interface



## 3.2 LGA Interface Definition

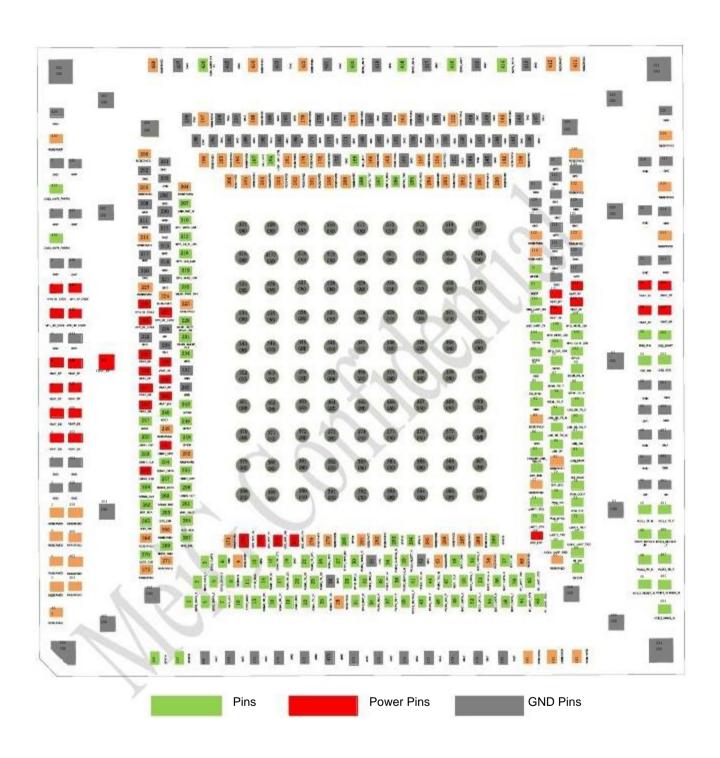


Figure 2 Module serial number pin diagram

#### Remark:

Module serial number pin diagram is the actual wiring name inside the module;



# 3.3 Pin Description

The following table shows the definition of each pin of MA922 module.

Table 2 IO parameter definition

No.	Name	1/0	Electrical Level	Description	Remark
1	SDC2_DATA_0	DIO		SDIO2 data bit 0	
2	SDC2_DATA_1	DIO	V <sub>I</sub> нmin = 1.27 V	SDIO2 data bit 1	1.8 V power
3	SDC2_CLKFB	DIO	Vінтах = 2.0 V Vігтах = 0.58 V Vонтіп = 1.4 V	SDIO2 data strobe	domain

Table 3 Pin Description 4 SDC2\_DATA\_2

ATA\_2 DIO SDIO2 data bit 2

No.	Name	I/O	Electrical Level	Description	Remark
51	SPC22DATA30	PBO		SDIO2 data bit 30	
62	GND SDC2_DATA_1	GDIO	Vıнmin = 1.27 V	GND SDIO2 data bit 1	1.8 V power
Type 3 IO DI		Vıнm utput bio	ax = 2.0 V lire <b>çtional</b> , sionale ∨ Voнmin = 1.4 V	SDIO2 data strobe	domain
DO QD AI BOT	SDC2_DATA_2Open-drain Analog sign	Digital output signal.  SDC2_DATA_2Open-drain output signal.  Analog signal input  Bidirectional signal with open-drain output.		SDIO2 data bit 2	
PI PO G	power input SDC2_DATA_3 <sub>Power</sub> DIC Ground			SDIO2 data bit 3	
6	GND	G		GND	

Type Description

IO Input and output bidirectional signal.

DO Digital output signal.

OD Open-drain output signal.

MEIG	美格			MA922 Hard	dware Design Manua
7	PWR_KEY	DI		Turn on/off the module	Valid low level
8	RESIN_N	DI		Reset the module	Valid low level
9	RESERVED				
10	ETH0_MDIO	DIO	V <sub>I</sub> нmin = 1.17 V V <sub>I</sub> Lmax = 0.63 V	Ethernet data	Close to external PHY plus pull-up resistor
11	ETH0_MDC	DO	Vонmin = 1.35 V Volmax = 0.45 V	он <b>min = 1.35</b> V	
12	GND	G		GND	
13	RGMII_RX_D0	DI		RGMII receive data bit 0	
14	RGMII_RX_D1	DI		RGMII receive data bit 1	
15	RGMII_RX_CTL	DI		RGMII receive control	
16	RGMII_RX_D2	DI		RGMII receive data bit 2	
17	RGMII_RX_D3	DI		RGMII receive data bit 3	
18	GND	G		GND	

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19	RGMII_RXC	DI	F
20	RGMII_TX_D0	DO	F
21	RGMII_TX_CTL	DO	F
22	RGMII_TX_D1	DO	F
23	RGMII_TX_D2	DO	F
24	RGMII_TXC	DO	F
25	RGMII_TX_D3	DO	F
26	GND	G	(

19	RGMII_RXC	DI		RGMII receive	
20	RGMII_TX_D0	DO		RGMII transmit data bit 0	
21	RGMII_TX_CTL	DO		RGMII transmit control	
22	RGMII_TX_D1	DO		RGMII transmit data bit 1	
23	RGMII_TX_D2	DO		RGMII transmit data bit 2	
24	RGMII_TXC	DO		RGMII transmit clock	
25	RGMII_TX_D3	DO		RGMII transmit data bit 3	
26	GND	G		GND	
27	ETH1_PWR_EN	DO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	Enable external power supply to power Ethernet PHY	
28	RESERVED				Keep pin open
29	ETH0_INT_N	DI	V <sub>I</sub> нmin = 1.26 V V <sub>I</sub> нmax = 2.1 V	Ethernet PHY interrupt input	
30	PCIE0_WAKE_N	DIO	V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	PCIe wake up	Input in RC mode, output in EP mode

MEIG	美格	1		MA922 Hard	lware Design Manual
31	ETH0_RST_N	DO		Reset output for Ethernet PHY	
32	PCIE0_RX0_M	AI		PCIE0_RX0_M	
33	GND	G		GND	
34	PCIE0_RX0_P	AI		PCIE0_RX0_P	
35	PCIE0_RX1_M	AI		PCIE0_RX1_M	
36	PCIE0_CLKREQ_N	DIO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VoLMAX = 0.45 V	PCle1 clock request	Input in RC mode, output in EP mode
37	PCIE0_RX1_P	Al			
38	PCIE0_REFCLK_M	AIO		PCIE0_REFCLK_	Input in RC
39	PCIE0_RESET_N	DIO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V		mode, output
40	PCIE0_REFCLK_P	AIO		PCIE0_REFCLK_	
41	PCIE0_TX1_M	AO		PCIE0_TX1_M	
42	GND	G		GND	

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43	PCIE0_TX1_P	AO		PCIE0_TX1_P	
44	PCIE0_TX0_M	AO		PCIE0_TX0_M	
45	RESERVED				Keep pin open
46	PCIE0_TX0_P	AO		PCIE0_TX0_P	
47	SDC1_CLK	DO		SDIO1 clock	
48	SDC1_CMD	DIO		SDIO1 command	1.8 V power
49	SDC1_DATA_0	DIO	Vıнmin = 1.27 V	SDIO1 data bit	
50	SDC1_DATA_1	DIO	V <sub>I</sub> Hmax = 2.0 V V <sub>I</sub> Lmax = 0.58 V V <sub>O</sub> Hmin = 1.4 V V <sub>O</sub> Lmax = 0.45 V	SDIO1 data bit	domain.
51	SDC1_DATA_2	DIO		SDIO1 data bit	
52	SDC1_DATA_3	DIO		SDIO1 data bit	
53	SDC1_DATA_4	DIO		SDIO1 data bit	
54	RESERVED				Keep pin open

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55	SDC1_DATA_5	DIO		SDIO1 data bit	
56	SDC1_DATA_6	DIO	V <sub>I</sub> Hmin = 1.27 V V <sub>I</sub> Hmax = 2.0 V	SDIO1 data bit	1.8 V power
57	SDC1_DS	DIO	V <sub>I</sub> Lmax = 0.58 V V <sub>O</sub> Hmin = 1.4 V V <sub>O</sub> Lmax = 0.45 V	SDIO1 data strobe	domain.
58	SDC1_DATA_7	DIO		SDIO1 data bit	
59	BT_UART_TXD	DO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	Bluetooth UART transmit	1.8V power domain, suspended if not used
60	RESERVED				Keep pin open
61	BT_UART_RTS	DI	Vıнmin = 1.26 V	Module Bluetooth receive data Receive slave device RTS	1.8V power
62	BT_UART_CTS	DO	V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	Module Bluetooth receive data Receive slave device CTS	domain, suspended if not used
63	BT_UART_RXD	DI		Bluetooth UART receive	
64	GPIO13	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
65	RESERVED				Keep pin open
66	BT_EN	DO	VIHmin = 1.17 V VILmax = 0.63 V VOHmin = 1.44 V VOLmax = 0.36	Bluetooth enable control	



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67	COEX_UART_RXD	DO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	LTE & WLAN & Bluetooth coexistence UART receive	
68	VDD_EXT	РО	VIHnom=1.8V Io <sub>max</sub> = 50 mA	Provide 1.8 V for external circuits	Power supply for external pull up circuits.
69	COEX_UART_TXD	DO	VIHmin = 1.26 V VIHmax = 2.1 V VILmax = 0.54 V VoHmin = 1.35 V VoLmax = 0.45 V	LTE & WLAN & Bluetooth coexistence UART transmit	
70	UART1_TXD	DO	V <sub>I</sub> нmin = 1.26 V	UART1 transmit	1.8V power
71	UART1_CTS	DO	V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	DTE clear to send signal from DCE (Connects to DTE's CTS)	domain, suspended if not used
72	UART1_RXD	DI	Volume V	UART1 receive	
73	PCM_SYNC	DIO		PCM data frame sync	1.8V power domain, master mode output, slave mode input
74	UART1_RTS	DI	send s	DTE request to send signal to DCE (Connects to DTE's RTS)	1.8V power domain, suspended if not used
75	PCM_CLK	DIO	V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	PCM clock	1.8V power domain, master mode output, slave mode input
76	PCM_DIN	DI		PCM data input	1.8 V power domain.
77	RESERVED				Keep pin open
78	PCM_DOUT	DO	VIHmin = 1.26 V VIHmax = 2.1 V VILmax = 0.54 V VoHmin = 1.35 V VoLmax = 0.45 V	PCM data output	1.8 V power domain.



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79	I2C1_SCL	OD	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V	I2C1 serial clock	External pull-up resistors are required. 1.8V power
80	I2C1_SDA	OD	VoLmax = 0.45 V	I2C1 serial data	domain, suspended if not used.
81	I2S_MCLK	DO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	Clock output for codec	12.288 MHz clock output
82	RESERVED				Keep pin open
83	FORCED_USB_BOO	DI	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	Force download	High level active, recommended to reserve a test point.
84	USB_VBUS	AIO	Vnom=5.0V	USB connection detect	recommended to reserve a test point.
85	USB_DP	AIO		USB 2.0 DP	
86	GND	G		GND	
87	USB_DM	AIO		USB 2.0 DM	
88	USB_SS_RX_M	AI		USB 3.1 Receiving signal cable RX_M	
89	RESERVED				Keep pin open
90	USB_SS_RX_P	AI		USB 3.1 Receiving signal cable RX_P	

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91	USB_SS_TX_M	AO		USB 3.1 Transmission signal cable TX_M	
92	GND	G		GND	
93	USB_SS_TX_P	AO		USB 3.1 Transmission signal cable TX_P	
94	SGMII_TX_P	AO		SGMII_TX_P	
95	DR_SYNC	DO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	Dead reckoning sync	
96	SGMII_TX_M	AO		SGMII_TX_M	
97	SGMII_RX_P	AI		SGMII_RX_P	
98	GND	G		GND	
99	SGMII_RX_M	AI		SGMII_RX_M	
100	GPIO1	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
101	GPIO2	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
102	GPIO3	DIO	VILnom=0V VIHnom=1.8V	GPIO	Not support wake-up interrupt.



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103	SPI2_CLK_LGA	DO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	SPI2 clock	Supports SPI Master and Slave mode .	
104	GPIO4	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.	
105	SPI2_CS_N_LGA	DO		SPI2 chip select	Supports SPI Master and Slave mode .	
106	SPI2_MISO_LGA	DI	V⊮min = 1.26 V	SPI2 master-in slave-out	Supports SPI Master and Slave mode .	
107	DBG_UART_TX	DO	V <sub>I</sub> нтах = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V Debug UART		1.8V power domain, suspended if not used.recomme nded to reserve a test point.
108	SPI2_MOSI_LGA	DO		SPI2 master-out	Supports SPI Master and Slave mode .	
109	VBAT_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's RF part		
110	DBG_UART_RX	DI	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	Debug UART receive	1.8V power domain, suspended if not used.recomme nded to reserve a test point.	
111	VBAT_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's RF part		
112	VBAT_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's RF part		
113	ADC2	AI	Voltage range: 0–1.875 V	General-purpose  ADC interface		



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114	VBAT_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's RF part	
115	GND	G		GND	
116	GPIO5	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
117	GND	G		GND	
118	GND	G		GND	
119	RESERVED				Keep pin open
120	GND	G		GND	
121	GND	G		GND	
122	RESERVED				Keep pin open
123	RESERVED				Keep pin open
124	GND	G		GND	
125	GND	G		GND	

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126	GND	G	GND	
127	GND	G	GND	
128	GND	G	GND	
129	GND	G	GND	
130	GND	G	GND	
131	GND	G	GND	
132	RESERVED			Keep pin open
133	GND	G	GND	
134	GND	G	GND	
135	GND	G	GND	
136	RESERVED			Keep pin open
137	GND	G	GND	

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138	GND	G	GND	
139	RESERVED			Keep pin open
140*	GND	G	GND	
141	GND	G	GND	
142	RESERVED			Keep pin open
143	RESERVED			Keep pin open
144-151	GND	G	GND	
152	RESERVED			Keep pin open
153	GND	G	GND	
154	RESERVED			Keep pin open
155	GND	G	GND	
156	GND	G	GND	

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157	RESERVED				Keep pin open		
158	GND	G		GND			
159	GND	G		GND			
160	GND	G		GND			
161	RESERVED				Keep pin open		
162	GND	G		GND			
163	RESERVED				Keep pin open		
164	GND	G		GND			
165	GND	G		GND			
166	RESERVED				Keep pin open		
167	GND	G		GND			
168	GND	G		GND			



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169	IMU_INT1	DI	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	IMU interrupt 1	
170	RESERVED				Keep pin open
171	GND	G		GND	
172	GND	G		GND	
173	GND	G		GND	
174	GND	G		GND	
175	RESERVED				Keep pin open
176	GND	G		GND	
177	GND	G		GND	
178	RESERVED				Keep pin open
179	RESERVED				Keep pin open
180	GND	G		GND	

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181	RESERVED				Keep pin open
182	GND	G		GND	
183	GND	G		GND	
184	HOST_SW_CTRL	DI	VIHmin = 1.17 V VILmax = 0.63 V VOHmin = 1.44 V VOLmax = 0.36	Switch control	
185	GND	G		GND	
186	GND	G		GND	
187	IMU_INT2	DI	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	IMU interrupt 2	
188	RESERVED				Keep pin open
189	GND	G		GND	
190	RESERVED				Keep pin open
191	GND	G		GND	

GND

G

GND

192

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193	RESERVED				Keep pin open
194	GND	G		GND	
195	GND	G		GND	
196	RESERVED				Keep pin open
197	RESERVED				Keep pin open
198	GND	G		GND	
199	GND	G		GND	
200	RESERVED				Keep pin open
201	GND	G		GND	
202	GND	G		GND	
203	GND	G		GND	
204	RESERVED				Keep pin open

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205	RESERVED				Keep pin open		
206	GND	G		GND			
207	HSM_RST_N	DO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	Reset output to external HSM			
208	GND	G		GND			
209	GND	G		GND			
210	SPI1_MOSI_LGA	DO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	SPI1 master-out	Supports SPI Master and Slave mode .		
211	GND	G		GND			
212	GND	G		GND			
213	SPI1_CS_N_LGA	DO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	SPI1 chip select	Supports SPI Master and Slave mode .		
214	RESERVED				Keep pin open		
215	GND	G		GND			
216	SPI1_CLK_LGA	DO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V	SPI1 clock	Supports SPI Master and Slave mode .		

Volmax = 0.45 V

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217	GND	G		GND	
218	GND	G		GND	
219	SPI1_MISO_LGA	DI	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	SPI1 master-in slave-out	Supports SPI Master and Slave mode .
220	GND	G		GND	
221	GND	G		GND	
222	WLAN_PWR_EN1	DO	VIHmin = 1.17 V VILmax = 0.63 V VOHmin = 1.44 V VOLmax = 0.36	WLAN power supply enable control 1	Used for Quectel AF50T VDD_RF power control.
223	RESERVED				Keep pin open
224	RESERVED				
225	RESERVED				Keep pin open
226	VPH_5V_CV2X	PI	Vmax = 5.25 V Vmin = 4.75 V Vnom = 5.0 V	Power supply for the module's C-V2X part	
227	VPH_5V_CV2X	PI	Vmax = 5.25 V Vmin = 4.75 V Vnom = 5.0 V	Power supply for the module's C-V2X part	
228	WLAN_HSTP_WLAN _EN	DO		WLAN function enable control	

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229	VPH_5V_CV2X	PI	Vmax = 5.25 V Vmin = 4.75 V Vnom = 5.0 V	Power supply for the module's C-V2X part	
230	GND	G		GND	
231	WLAN_SLEEP_CLK	DO		WLAN 32 kHz sleep clock	
232	GND	G		GND	
233	GND	G		GND	
234	GND	G		GND	
235	VPH_PWR1_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for	
236	VPH_PWR1_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	the module's RF part	
237	GND	G		GND	
238	VPH_PWR1_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for	
239	VPH_PWR1_RF	PI	Vmax = 4.3 V	the module's RF part	

GND

VPH\_PWR1\_RF

240

G

Vmin = 3.3 VVnom = 3.8 V

GND

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241	VBAT_BB	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for	
242	VBAT_BB	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	the module's baseband part	
243	GPIO6	DIO	VILnom=0V VIHnom=1.8V	GPIO	Not support interrupt wake-up
244	VBAT_BB	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's baseband part	
245	ADC1	AI	Voltage range: 0–1.875 V	General-purpose  ADC interface	
246	GPIO7	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
247	ADC0	AI	Voltage range: 0–1.875 V	General-purpose  ADC interface	
248	RESERVED				Keep pin open
249	GPIO8	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
250	USIM1_RST	DO	For 1.8 V VIHmin = 1.26 V VILmax = 0.36 V VOHmin = 1.44 V VOLmax = 0.4 V For 3.0 V (U)SIM: VIHmin = 2.1 V VILmax = 0.6 V VOHmin = 2.4 V VOLmax = 0.4 V	(U)SIM1 reset signal	
251	USIM1_VDD	PO	For 1.8 V (U)SIM: VOmax = 1.95 V VOmin = 1.65 V VOnom = 1.8 V For 3.0 V (U)SIM: VOmax = 3.05 V	(U)SIM1 card power supply	Either 1.8 V or 3.0 V is supported by the module automatically.

VOmin = 2.7 V

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			VOnom = 2.95 V		
252	RESERVED				Keep pin open
253	USIM1_CLK	DO	For 1.8 V VIHmin = 1.26 V VILmax = 0.36 V VOHmin = 1.44 V VOLmax = 0.4 V For 3.0 V (U)SIM: VIHmin = 2.1 V VILmax = 0.6 V VOHmin = 2.4 V VOLmax = 0.4 V	(U)SIM1 clock data	
254	USIM1_DATA	DIO	For 1.8 V VIHmin = 1.26 V VILmax = 0.36 V VOHmin = 1.44 V VOLmax = 0.4 V For 3.0 V (U)SIM: VIHmin = 2.1 V VILmax = 0.6 V VOHmin = 2.4 V VOLmax = 0.4 V	(U)SIM1 card data	
255	USIM1_DET	DI	VIHmax = 2.1 V VIHmin = 1.26 V VILmax = 0.54 V	(U)SIM1 card hotplug detect	1.8 V power domain.If unused, keep them open
256	USIM2_VDD	PO	For 1.8 V (U)SIM: VOmax = 1.95 V VOmin = 1.65 V VOnom = 1.8 V For 3.0 V (U)SIM: VOmax = 3.05 V VOmin = 2.7 V VOnom = 2.95 V	(U)SIM2 card power supply	Either 1.8 V or 3.0 V is supported by the module automatically.
257	USIM2_DATA	DIO	For 1.8 V VIHmin = 1.26 V VILmax = 0.36 V VOHmin = 1.44 V VOLmax = 0.4 V For 3.0 V (U)SIM: VIHmin = 2.1 V VILmax = 0.6 V VOHmin = 2.4 V VOLmax = 0.4 V	(U)SIM2 data signal	
258	USIM2_DET	DI	VIHmax = 2.1 V VIHmin = 1.26 V VILmax = 0.54 V	(U)SIM2 card hotplug detect	1.8 V power domain.If unused, keep them open

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259	USIM2_CLK	DO	For 1.8 V VIHmin = 1.26 V VILmax = 0.36 V VOHmin = 1.44 V VOLmax = 0.4 V For 3.0 V (U)SIM: VIHmin = 2.1 V VILmax = 0.6 V VOHmin = 2.4 V VOLmax = 0.4 V	(U)SIM2 clock signal	
260	USIM2_RST	DO	For 1.8 V VIHmin = 1.26 V VILmax = 0.36 V VOHmin = 1.44 V VOLmax = 0.4 V For 3.0 V (U)SIM: VIHmin = 2.1 V VILmax = 0.6 V VOHmin = 2.4 V VOLmax = 0.4 V	(U)SIM2 reset signal	
261	I2S1_DOUT	DO	. V⊪min = 1.26 V	I2S data out	1.8 V power domain.
262	I2S1_SCK	DIO	VIHMIN = 1.20 V  VIHMAX = 2.1 V  VILMAX = 0.54 V  VOHMIN = 1.35 V  VOLMAX = 0.45 V	I2S1 clock	1.8 V power domain.Serve as output signals in master mode. Serve as input signals in slave mode.
263	12S1_DIN	DI		I2S data in	1.8 V power domain.
264	I2C2_SDA	OD	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	I2C2 serial data	External pull-up resistors are required. 1.8 V power domain.If unused, keep them open.
265	I2S1_WS	DIO	VIHMIN = 1.26 V VIHMAX = 2.1 V VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	I2S1 word select	1.8 V power domain.Serve as output signals in master mode. Serve as input signals in slave mode.
266	RESERVED				



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267	I2C2_SCL  RESERVED	OD	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	I2C2 serial clock	External pull-up resistors are required. 1.8 V power domain.If unused, keep them open.
269	SDC2_CMD	DO	V <sub>I</sub> Hmin = 1.27 V V <sub>I</sub> Hmax = 2.0 V V <sub>I</sub> Lmax = 0.58 V	SDIO2 command	1.8 V power
270	SDC2_CLK	DO	Vo <sub>H</sub> min = 1.4 V Vo <sub>L</sub> max = 0.45 V	SDIO2 clock	domain
271	RESERVED				Keep pin open
272	RESERVED				Keep pin open
273	RESERVED				Keep pin open
274	VDD_WIFI_VL	PO	lomax = 1.7 A	Low-voltage power supply for Wi-Fi & Bluetooth modules	
275	VDD_WIFI_VL	PO	lomax = 1.7 A	Low-voltage power supply for Wi-Fi & Bluetooth modules	
276	VDD_WIFI_VM	PO	Iomax = 450mA	Medium-voltage power supply for Wi-Fi & Bluetooth Modules	
277	VDD_WIFI_VH	РО	Iomax = 450mA	High-voltage power supply for Wi-Fi & Bluetooth Modules	

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278	RESERVED				Keep pin open
279	RESERVED				Keep pin open
280	GPIO9	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
281	RESERVED				Keep pin open
282	RESERVED				Keep pin open
283	GPIO10	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
284	GPIO11	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.
285	RESERVED				Keep pin open
286	RESERVED				Keep pin open
287	RESERVED				Keep pin open
288	RESERVED				Keep pin open
289	GPIO12	DIO	VILnom=0V VIHnom=1.8V	GPIO	Support wake-up interrupt.

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MEIG	美格			MA922 Hard	ware Design Manual
290	RESERVED				Keep pin open
291	RESERVED				Keep pin open
292	RESERVED				Keep pin open
293	RESERVED				Keep pin open
294	RESERVED				Keep pin open
295	UART4_RXD	DI		Receive signal	
296	UART4_TXD	DO	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V	Transmit signal	domain.
297	UART3_RXD	DI	V <sub>I</sub> Lmax = 0.54 V Vo⊢min = 1.35 V Vo∟max = 0.45 V	Receive signal	If unused, keep these pins open.
298	UART3_TXD	DO		Transmit signal	
299-306	RESERVED				Keep pin open
307-402	GND	G		GND	
403	VBAT_RF	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's RF part	

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MEIG	美格	1	MA922 Hard	ware Design Manual
404	GND	G	GND	
405	GND	G	GND	
406	GND	G	GND	
407	GND	G	GND	
408	GND	G	GND	
409	GND	G	GND	
410	GND	G	GND	
411	RESERVED			Keep pin open
412	RESERVED			Keep pin open
413	GND	G	GND	
414	SDR0_ANT0	AIO	Main antenna interface	50 Ω impedance
415	GND	G	 GND	



PILIO		1	T	IVII (SZZ FIAI G	ware Design Manual
416	SDR0_ANT1	AIO		Main antenna interface	50 Ω impedance
417	GND	G		GND	
418	SDR0_ANT2	AI		MIMO2 antenna interface	
419	GND	G		GND	
420	SDR0_ANT3	AI		MIMO3 antenna interface	
421	GND	G		GND	
422	RESERVED				Keep pin open
423	GND	G		GND	
424	RESERVED				Keep pin open
425	GND	G		GND	
426	SDR_GNSS_ANT4	AI		GPS antenna interface	
427	GND	G		GND	

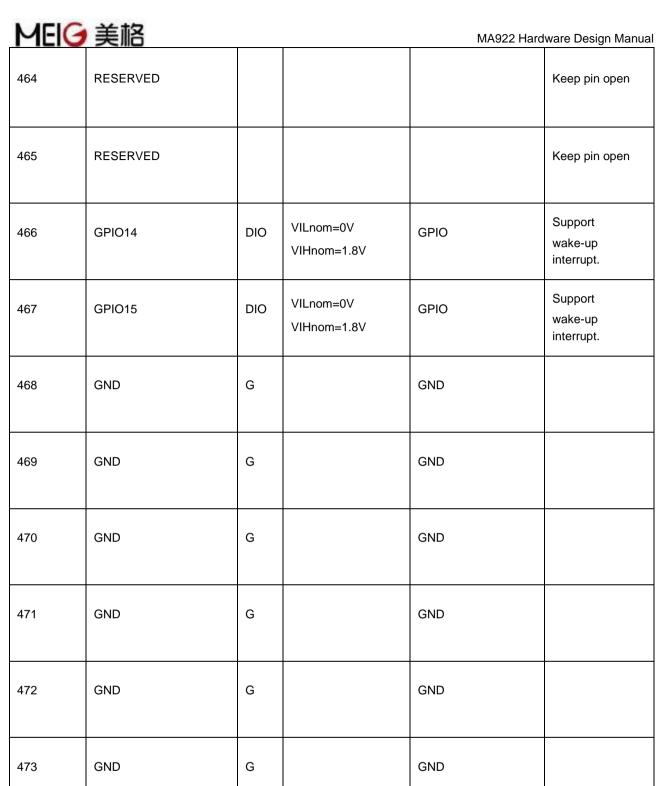
MEIG	MEIG 美船 MA922 Hardware Design Manua						
428	RESERVED				Keep pin open		
429	GND	G		GND			
430	RESERVED				Keep pin open		
431	GND	G		GND			
432	GND	G		GND			
433	CV2X_ANT5_FAKRA	AIO		CV2X_ANT5 antenna interface			
434	GND	G		GND			
435	GND	G		GND			
436	CV2X_ANT6_FAKRA	AIO		CV2X_ANT6 antenna interface			
437	GND	G		GND			
438	GND	G		GND			
439	VPH_5V_CV2X	PI	Vmax = 5.25 V Vmin = 4.75 V	Power supply for the module's			

Vmin = 4.75 V Vnom = 5.0 V

C-V2X part

MEIG	美格	I		MA922 Hard	ware Design Manual
440	VPH_5V_CV2X	PI			
441	VPH_5V_CV2X	PI			
442	VPH_5V_CV2X	PI			
443	GND	G		GND	
444	GND	G		GND	
445	VBAT_RF	PI			
446	VBAT_RF	PI	Vmax = 4.3 V Vmin = 3.3 V	Power supply for the module's RF	
447	VBAT_RF	PI	Vnom = 3.8 V	part	
448	VBAT_RF	PI			
449	VBAT_BB	PI	Vmax = 4.3 V Vmin = 3.3 V	Power supply for the module's	
450	VBAT_BB	PI	Vnom = 3.8 V	baseband part	
451	VBAT_BB	PI	Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V	Power supply for the module's baseband part	

MEIG	美格		MA922 Hard	ware Design Manual
452	VBAT_BB	PI		
453	GND	G	GND	
454	GND	G	GND	
455	GND	G	GND	
456	GND	G	GND	
457	RESERVED			Keep pin open
458	RESERVED			Keep pin open
459	RESERVED			Keep pin open
460	RESERVED			Keep pin open
461	RESERVED			Keep pin open
462	RESERVED			Keep pin open
463	RESERVED			Keep pin open



G

G

GND

GND

**GND** 

GND

474

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MEIG	美格			MA922 Hard	ware Design Manual
476	GND	G		GND	
477	GND	G		GND	
478	GND	G		GND	
479	GND	G		GND	
480	GND	G		GND	
481	RESERVED				Keep pin open
482	RESERVED				Keep pin open
483	RESERVED				Keep pin open
484	PCIE2_WAKE_N	DIO	Vıнmin = 1.26 V	PCIe wakeup	Only used in RC mode and
485	PCIE2_CLKREQ_N	DIO	V <sub>I</sub> Hmax = 2.1 V V <sub>I</sub> Lmax = 0.54 V V <sub>O</sub> Hmin = 1.35 V V <sub>O</sub> Lmax = 0.45 V	PCIe clock request	serve as input signals in RC mode.
486	PCIE2_RESET_N	DIO	VOLINIAX — U.40 V	PCIe reset	Only used in RC mode and serve as Output signals in RC mode.
487	PCIE2_RX_P	AI		PCIE2_RX_P	

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MEIG	美格	ı	MA922 Hard	ware Design Manual
488	PCIE2_RX_M	AI	PCIE2_RX_M	
489	PCIE2_REFCLK_P	AO	PCIE2_REFCLK_ P	Only used in RC mode and
490	PCIE2_REFCLK_M	AO	PCIE2_REFCLK_	serve as Output signals in RC mode.
491	PCIE2_TX_P	AO	PCIE2_TX_P	
492	PCIE2_TX_M	AO	PCIE2_TX_M	
493	GND	G	GND	
494	GND	G	GND	
495	GND	G	GND	
496	GND	G	GND	
497	GND	G	GND	
498	GND	G	GND	

GND

G

GND

499

MEIG	美格			MA922 Hard	ware Design Manual
500	GND	G		GND	
501	GND	G		GND	
502	GND	G		GND	
503	12S2_SCK	DO		I2S1 clock signal	1.8 V power domain.Serve as output signals in
504	I2S2_WS	Ю	V <sub>I</sub> Hmin = 1.26 V V <sub>I</sub> Hmax = 2.1 V	I2S1 select signal	master mode. Serve as input signals in slave mode.
505	I2S2_DOUT	DO VILMAX = 0.54 V VOHMIN = 1.35 V VOLMAX = 0.45 V	I2S data out	1.8 V power	
506	I2S2_DIN	DI		I2S data in	domain.
507	VBAT_RF	PI			
508	VBAT_RF	PI	Vmax = 4.3 V  Vmin = 3.3 V  Vnom = 3.8 V	Power supply for the module's RF	
509	VBAT_RF	PI		part	
510	VBAT_RF	PI			
511	GND	G		GND	

MEIG	美脂		 MA922 Hard	ware Design Manual
512	GND	G	GND	
513	RESERVED			Keep pin open
514	GND	G	GND	
515	GND	G	GND	
516	RESERVED			Keep pin open
517	GND	G	GND	
518	GND	G	GND	
519	RESERVED			Keep pin open
520-524	GND	G	GND	

#### Remark:

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- 1. \* means that the function is under development;
- 2. The above interface functions are not supported at the same time, some pins are multiplexed functions, please pay attention when choosing!
- 3. MA922 pin multiplexing see "MA922 \_GPIO function multiplexing"



#### O.T I OWG

Table 4 MA922 module power interface description

Pin Name	I/O	Pin	Description
VBAT_RF	PI	109, 111, 112, 114, 235, 236, 238, 239, 445, 446, 447, 448, 507, 508, 509, 510 403	Module power supply,3.3~4.3V, nominal value 3.8V
VBAT_BB	PI	241, 242, 244, 449, 450, 451, 452	Module power supply, 3.3~4.3V, nominal value 3.8V
VBAT_CV2X	PI	226, 227, 229, 439, 440, 441, 442	Module C-V2X power supply, 4.75~5.25V, nominal value 5.0V
VDD_EXT	РО		Voltage output, 1.8V
GND	G	6,12,18,26,33,42,86,92,98,115,117,118,120,121, 124,125,126,127,128,129,130,131,133,134,135,137,138,140, 141,144,145,146,147,148, 149, 150,151,153,155,156,158, 159,160,162,164,165, 167, 168, 171, 172, 173, 174, 176, 177, 180, 182, 183, 185, 186, 189, 191, 192, 194, 195, 198, 199, 201, 202, 203, 206,208, 209, 211, 212, 215, 217, 218, 220, 221, 230, 232, 233, 234, 237, 240, 307, 308,309, 310, 311, 312, 313, 314, 315, 316, 317, 318, 319, 320, 321, 322, 323, 324, 325,326, 327, 328, 329, 330, 331, 332, 333, 334, 335, 336, 337, 338, 339, 340, 341, 342,343, 344, 345, 346, 347, 348, 349, 350, 351, 352, 353, 354, 355, 356, 357, 358, 359,360, 361, 362, 363, 364, 365, 366, 367, 368, 369, 370, 371, 372, 373, 374, 375, 376,377, 378, 379, 380, 381, 382, 383, 384, 385, 386, 387, 388, 389, 390, 391, 392, 393,394, 395, 396, 397, 398, 399, 400, 401, 402, 404, 405, 406, 407, 408, 409, 410, 413,415, 417, 419, 421, 423, 425, 427, 429, 431, 432, 434, 435, 437, 438, 443, 444, 453,454, 455, 456, 468, 469, 470, 471, 472, 473, 474, 475, 476, 477, 478, 479, 480, 493,494, 495, 496, 497, 498, 499, 500, 501, 502, 511, 512, 514, 515, 517, 518, 520, 521,522, 523, 524	



# 3.4.1 Power Supply

The following figure 3 shows a reference design for +12/+24 V input power source when applying the module to 5G + C-V2X solution. The designed outputs are 5.0 V and 3.8 V, and the maximum rated current is 5 A.

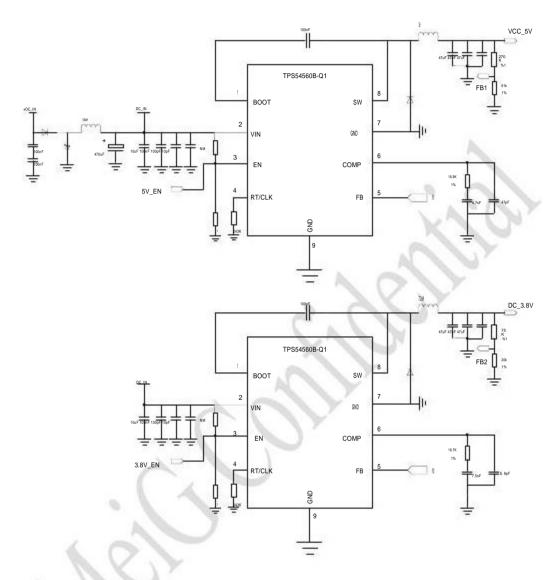


Figure 3 Module power supply circuit

The following figure shows another reference design for +12/+24 V input power source when applying the module to 5G + C-V2X solution. The designed outputs are 5.0 V (with maximum rated current of 5 A) and 3.8 V (with maximum rated current of 3 A).



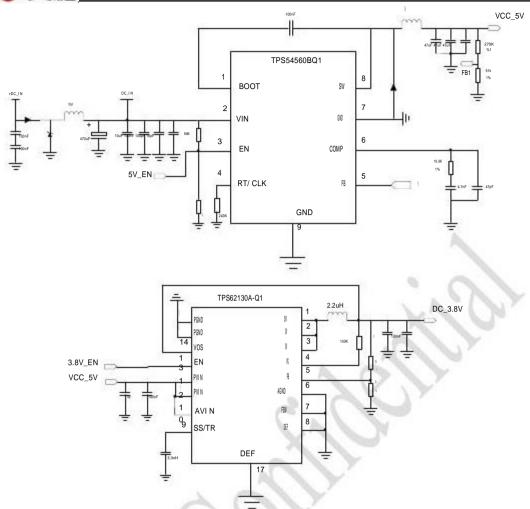


Figure 4 Module power supply circuit

## 3.4.2 Reduce Voltage Drop

The power supply range of VBAT\_BB and VBAT\_RF is 3.3–4.3 V. The power supply range of VBAT\_CV2X is 4.75–5.25 V. Ensure that the input voltage of VBAT\_BB and VBAT\_RF never drops below 3.3 V, and the input voltage of VBAT\_CV2X never drops below 4.75 V. The following figure shows the voltage drop during burst transmission in GSM and 5G (NSA) networks. The voltage drop will be less in 3G, 4G and 5G (SA) networks.

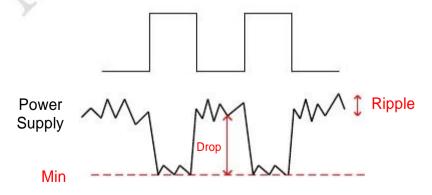


Figure 5 Burst transfer power requirements



To reduce voltage drop, VBAT\_RF and VPH\_5V\_V2X use bypass capacitors with at least 100uF and low ESR, and VBAT\_BB uses bypass capacitors with at least 220uF and retains multi-layer ceramic chip capacitor (MLCC) arrays due to their low ESR. It is recommended that at least three ceramic capacitors (100nf, 33pf, 10pf) be used to form the MLCC array and that these capacitors be placed close to the VBAT pins. When the module is connected to an external 3.8V power supply, the VBAT\_BB and VBAT\_RF cables are in a star structure. VBAT\_BB cable width should not be less than 1.5 mm. The VBAT\_RF cable width of the main power cable is not less than 3mm, and the branch cable width is not less than 2mm. VPH\_5V\_V2X Cable width should not be less than 1.6 mm. In principle, the longer the VBAT line, the wider the line width.

In addition, in order to make the power supply stable, it is recommended to use a TVS diode to prevent EOS and place it as close to the VBAT pin as possible. The recommended circuit diagram is as follows:

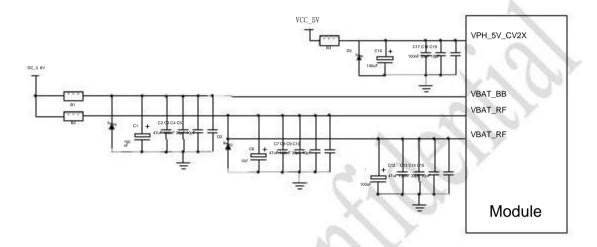


Figure 6 Power supply design

# 3.4.3 VDD\_EXT Voltage Output

When the MA922 module is powered on normally, Pin68 output voltage is 1.8V and current load is 50mA. This output voltage can be used as an external pull-up source, such as level reference.

## 3. 5 Power on/off

#### 3.5.1 PWRKEY Pin Power on

When the module is in power down mode, it can be turned on by driving the PWRKEY pin low for at least 500 ms. It is recommended to use an open drain/collector driver to control the PWRKEY. A simple reference circuit is illustrated in the following figure.



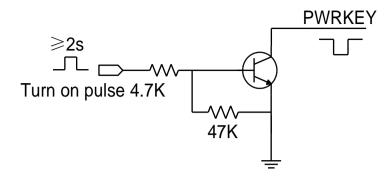


Figure 7 Open collector driver reference boot circuit

Another way to control the PWRKEY pin is to directly use a button switch. A TVS should be placed near the button for ESD protection. The reference circuit is as follows:

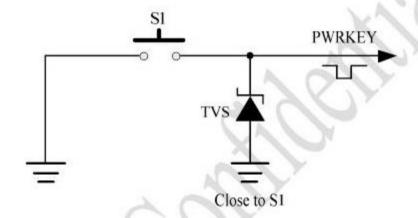


Figure 8 Button boot reference circuit

The boot timing (to be tested) is shown in the following figure:



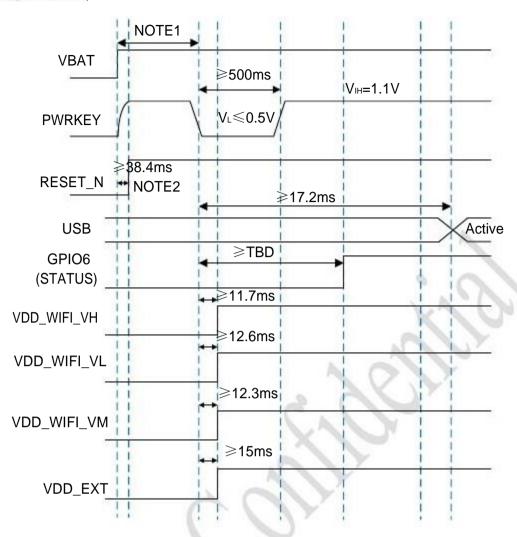


Figure 9 Boot sequence diagram

#### Note:

Before pulling down the PWRKEY pin, make sure that the VBAT voltage is stable. It is recommended that the time interval between powering up VBAT and pulling the PWRKEY pin low is no less than 30ms. If the module needs to be powered on automatically, the PWRKEY pin can be directly connected to the ground. The maximum resistance to ground cannot exceed 1k, and 0R is recommended. In this way, shutdown can only be done by direct powered off.

### 3.5.2 Shutdown

Table 5 Three shutdown modes:

Shutdown method	Step	Applicable scene
Low voltage shutdown	When VBAT voltage is too low or power down, the module will shutdown	At this time, the module does not perform the normal shutdown process, and does not go through the process of logging out from the base station.



Hardware shutdown	Pull down PWRKEY (greater than 3s), then release	Normal shutdown
AT shutdown	AT+CPOF	Software shutdown

Driving PWRKEY low for at least 2 s and then releasing it will enable the module to execute power-off procedure. The power-down scenario is illustrated in the following figure.

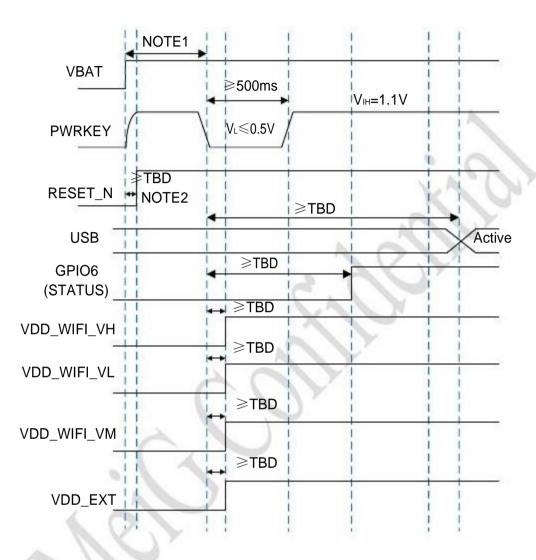


Figure 10 Power-down Timing

#### Remark:

- 1. When the module is working normally, do not cut off the power of the module immediately to avoid damaging the Flash data inside the module. It is strongly recommended to turn off the module through the AT command before disconnecting the power.
- 2. When using the AT command to shut down, make sure that PWRKEY is always in a high level state after the shutdown command is executed, otherwise the module will automatically restart after shutting down.

## 3. 6 Reset Function

There are two reset methods for MA922: hardware reset and AT command reset.



#### 3.6.1 Hardware Reset

When the module is working, pull down the RESET\_N pin for at least 250-550ms to reset the module. The RESET\_N signal is sensitive to interference, so it is recommended that the traces on the module interface board should be as short as possible, and should be handled with the ground.

The reference circuit is similar to the PWRKEY control circuit, and customers can use an open-collector drive circuit or a button to control the RESET\_N pin.

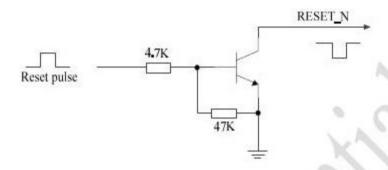


Figure 11 RESET\_N reset open collector reference circuit

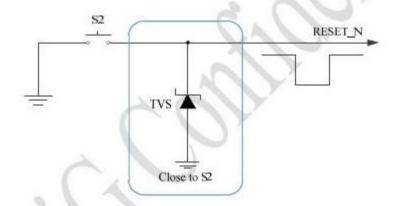


Figure 12 RESET\_N reset button reference circuit

The reset timing diagram is as follows:

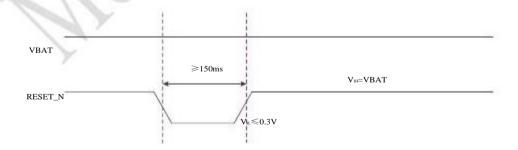


Figure 13 RESET\_N reset timing diagram

## 3.6.2 AT Command Reset

Input AT+TRB command through MA922 UART or USB AT port to reset and restart MA922.



# 7 USIM/SIM Interface

MA922 supports 1.8V and 3.0V SIM cards.

Table 6 USIM/SIM interface description

Pin name	I/O	Pin	Pin description
USIM1_VDD	PO	251	USIM1/SIM card power supply
USIM1_CLK	DO	253	USIM1/SIM card clock
USIM1_RESET	DO	250	USIM1/SIM card reset
USIM1_DATA	DIO	254	USIM1/SIM card data
USIM1_PRESENCE	DI	255	USIM1/SIM card hot-plug detect
USIM2_VDD	PO	256	USIM2/SIM card power supply
USIM2_CLK	DO	259	USIM2/SIM card clock
USIM2_RESET	DO	260	USIM2/SIM card reset
USIM2_DATA	DIO	257	USIM2/SIM card data
USIM2_PRESENCE	DI	258	USIM2/SIM card hot-plug detect

SIM card hot-plug
AT command
MA922 module supports (U)SIM card hot-plug via USIM\_DET pins, and either low-level or high-level

detection is supported. The function is disabled by default, **Bndletaub**etteratiled transwap detection function command.

is enabled, and the module detects whether the SIM AT+PENDING=1 open

card is inserted through the USIM\_PRESENCE pin
The SIM card hot-plug function can be configured through the "AT+SIMHOTSWAP" command. The AT
command description is shown in the following table:

command description is shown in the following table:

The SIM card hot swap detection function is disabled,

AT+PENDING= 0 close
Table 7 SIM card hot swap function setting description module reads the SIM card when powering on, and does not detect the USIM PRESENCE state

Pin name	I/O	Pin	Pin description
USIM1_VDD	PO	251	USIM1/SIM card power supply
USIM1_CLK	DO	253	USIM1/SIM card clock
USIM1_RESET	DO	250	USIM1/SIM card reset
USIM1_DATA	DIO	254	USIM1/SIM card data
USIM1_PRESENCE	DI	255	USIM1/SIM card hot-plug detect
USIM2_VDD	PO	256	USIM2/SIM card power supply
USIM2_CLK	DO	259	USIM2/SIM card clock
USIM2_RESET	DO	260	USIM2/SIM card reset
USIM2_DATA	DIO	257	USIM2/SIM card data

USIM2 PRESENCE DI 258 USIM2/SIM card hot-plug detect

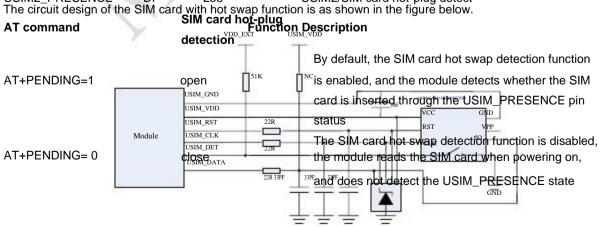


Figure 14 Reference design of card holder with hot-swap function



If you do not need to use the USIM card hot swap detection function, please keep the USIM\_DET pin floating. The reference circuit is as follows:

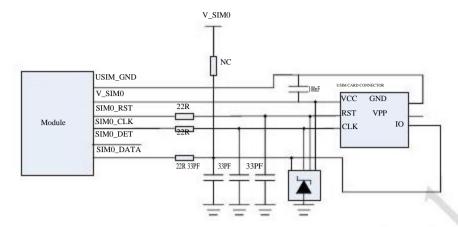


Figure 15 Reference design of card holder without hot-swap function

In the circuit design of the USIM card interface, in order to ensure the good performance and reliability of the USIM card, it is recommended to follow the following design principles in the circuit design:

- A 22Ω resistor is connected in series on the USIM\_DATA, USIM\_CLK and USIM\_RST lines to suppress stray EMI, enhance ESD protection, and facilitate debugging;
- In order to improve the anti-static ability, add TVS tubes to the USIM\_VDD, USIM\_DATA, USIM\_CLK and USIM\_RST lines, and the parasitic capacitance is not more than 30Pf ESD protection device;
- Connect 33pF capacitors in parallel on the USIM\_VDD, USIM\_DATA, USIM\_CLK and USIM\_RST lines to filter out GSM900 interference; the peripheral devices of the USIM card should be placed as close as possible to the USIM card holder;
- The USIM card holder is placed close to the module, try to ensure that the wiring length of the USIM card signal line does not exceed 100mm;
- ☐ The wiring of the USIM card signal line is far away from the RF line and the VBAT power line:
- In order to prevent crosstalk between USIM\_CLK signal and USIM\_DATA, the wiring of the two should not be too close, and a ground shield should be added between the two traces;

### 3. 8 USB Interface

The MA922 provides a USB interface. This interface is used for AT command interaction, data transfer, software debugging and version upgrading. Provides a USB interface, USB interface follows USB 3.1 Gen 2 and USB2.0 standards, USB 3.1 theoretically supports 10Gbps ultra-high speed, USB2.0 theoretically supports high-speed 480Mbps and full speed 12Mbps.

USB 2.0 and USB 3.1 share a hardware controller, so USB 2.0 and USB 3.1 cannot be used simultaneously. When USB 2.0 and USB 3.1 are connected to the same host, the default USB 3.1 interface is used.

#### 3.8.1 USB Pin Description



Table 8 USB interface description

Pin name	1/0	Pin	Description
USB_VBUS	DI	84	USB insertion detection, Maximum current: 0.1 mATypical 5.0 V.Test points must be reserved.
USB_DP	AIO	85	USB 2.0 Differential Data+,90Ω impedance
USB_DM	AIO	87	USB 2.0 Differential Data -,90Ω impedance
USB_SS_TX_P	AO	93	USB 3.1_TX_P, USB3.1 differential 70-100 $\Omega$ impedance, 85 $\Omega$ recommended
USB_SS_TX_M	AO	91	USB 3.1_TX_M
USB_SS_RX_P	Al	90	USB 3.1_RX_P
USB_SS_RX_M	Al	88	USB 3.1_RX_M

#### 3.8.2 USB Reference Circuit

It is recommended to use USB 2.0 for firmware upgrading in application designs, and test points must be reserved for debugging purposes. USB 2.0 interface reference circuit is presented below.

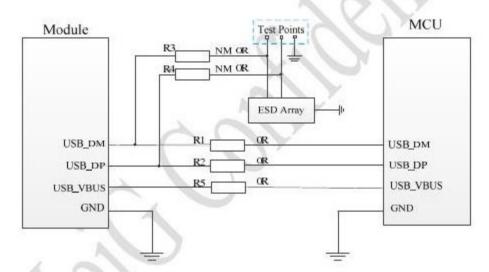


Figure 16 USB2.0 interface reference design diagram

In order to meet the signal integrity requirements of the USB 2.0 data cable, resistors R1/R2/R3/R4 must be placed close to the module, and the resistors need to be placed close to each other. The branch of the connection test point must be as short as possible.

The USB 3.1 interface reference circuit is shown in the following figure.



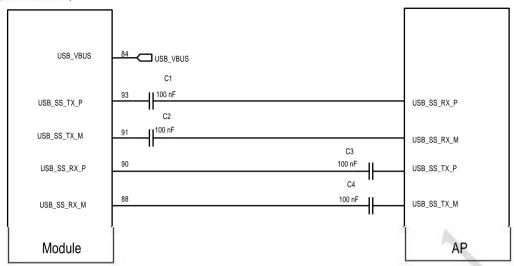


Figure 17 Reference design of USB 3.1 Application

In USB 3.1 applications, place C1 and C2 near the module, and place C3 and C4 near the AP. The extra stubs of trace must be as short as possible.

In the design of the USB interface circuit, in order to ensure the USB performance, it is recommended to follow the following principles in the circuit design:

- The module USB\_VBUS is not used to supply power to the module, but is used to detect the insertion and removal of USB:
- In order to reduce the signal interference during USB high-speed data transmission, connecting R1 and R2 in series on the USB\_DM and USB\_DP interface circuits can improve the accuracy of data transmission. It is recommended to use  $0\Omega$  for both R1 and R2;
- USB 2.0 and 3.1 signal differential routing packet ground processing. USB 2.0 recommends a differential impedance of  $90\Omega$ , and USB 3.1 recommends a differential impedance of  $85\Omega$ .
- The USB 2.0 wiring error should be less than 2.0mm, and the USB 3.1 wiring error should be less than 0.7mm.
- Do not line the crystal, oscillator, magnetic device, PCIE and RF signal. Differential wiring in the inner layer of the PCB, and three-dimensional package processing. The RF signal operates at 2.4 GHz with maximum isolation from the USB\_SS\_TX/RX trace.
- In order to improve the anti-static performance of the USB interface, it is recommended to add ESD protection devices to the USB\_DP and USB\_DM interface circuits, and it is recommended to use ESD devices with a junction capacitance of less than 1pF; the USB ESD protection devices should be placed as close to the USB interface as possible;
- In order to improve the anti-static performance of the USB interface, it is recommended to add ESD protection devices on the USB\_DP and USB\_DM interface circuits. USB 2.0 is recommended to use ESD devices with junction capacitance less than 1pF, and USB 3.1 is recommended to use parasitic capacitance less than 0.3pF. The USB ESD protection device should be placed as close as possible to the USB interface.
- Do not route USB cables under crystal oscillators, oscillators, magnetic devices, and RF signals. It is recommended to route the inner layer differential cables and wrap the ground on the top, bottom, left, and right sides.



#### Remark

- 1. The module supports master mode, but works in slave mode by default.
- 2. The high-speed PHY and SuperSpeed PHY share the same USB 3.1 Gen 2 controller inside baseband chipset, so USB 2.0 and USB 3.1 cannot be used simultaneously.
- 3. As for the AC coupling capacitors C1–C4, the recommended value is 220 nF for USB 3.1 Gen 2 and 100 nF for USB 3.1 Gen 1.

# 3.9 I2S and I2C Interfaces

The module provides one I2S interface and one I2C interface for external audio codec design. The module can provide a second I2C interface through pin multiplexing. ( I2C1&I2S1 default for Audio codec)

The following table shows the pin definition of I2S and I2C interfaces.

Table 9: Pin Definition of I2S Interface

Pin name	I/O	Pin	Describe	
I2S_MCLK	DO	81	Clock output for codec, 12.288MHz	
I2S1_WS	DIO	265	I2S1 word select, Serve as output signals in master mode.Serve as input signals in slave mode.	
I2S1_SCK	DIO	262	I2S1 clock, Serve as output signals in master mode.Serve as input signals in slave mode.	
I2S1_DIN	DI	263	I2S1data in	
I2S1_DOUT	DO	261	I2S1data out	
12S2_WS	DIO	504	I2S2 word select, Serve as output signals in master mode.Serve as input signals in slave mode.	
I2S2_SCK	DIO	503	I2S2 clock, Serve as output signals in master mode.Serve as input signals in slave mode.	
I2S2_DIN	DI	506	I2S2 data in	
I2S2_DOUT	DO	505	I2S2 data out	

<b>Pin name</b> Table 10: Pin Definition of I2C Interface		Pin	Describe	
I2C1_SDA Pin name I2C1_SCL	OD <b>I/O</b> OD	80 <b>Pin</b> 79	I2C1 serial data, Require external pull-up to 1.8 V.If unused keep them open. I2C1 serial clock, Require external pull-up to 1.8 V.If	,
12S_MCLK   12C2_SDA   1282_86	DO OD BIS	81 264 26 <del>5</del>	unused, Class powiewi peen.codec, 12.288MHz I2C2 serial data, Require external pull-up to 1.8 V.If unused, keep them open. I2S1 word selection external pull-up to 1.8 V.If I2C2 ses்ன் அன்.output signals in master mode. Serve unuseda is needs ignals appen.slave mode.	
12S1_SCK	DIO	262	I2S1 clock, Serve as output signals in master mode.Serve as input signals in slave mode.	
12S1_DIN	DI	263	I2S1data in	
<u>Ме</u> іР_Верн Technology Co.	, Ltgo	261	I2S1data out I2S2 word select,	67/119
12S2_WS	DIO	504	Serve as output signals in master mode. Serve	



The following figure shows a reference design of I2S and I2C interfaces with an external codec IC.

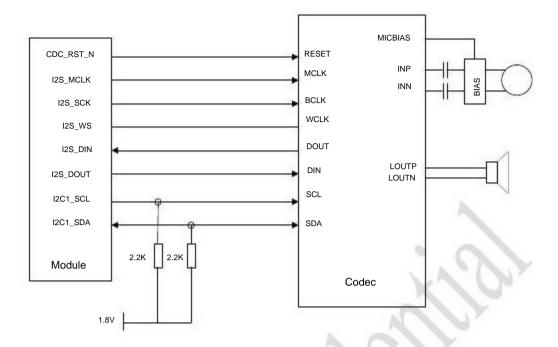


Figure 18 Reference design of I2C and I2S Interfaces with External Audio Codec

#### Remark:

- 1. It is recommended to reserve an RC circuit on the I2S signal traces, especially for I2S\_SCK and I2S\_MCLK.
- 2. The module works as a master device in I2C applications.

## 3.10 PCM Interfaces

The module provides one PCM interface for Bluetooth audio transmission by default. See *Chapter 4.7* for details. The PCM interface supports primary (short frame sync) and auxiliary (long frame sync) modes.

Table 11: Pin Definition of PCM Interface

Pin name	1/0	Pin	Description	
PCM_SYNC	DIO 73		PCM data frame sync, Serve as output signals in master mode. Serve as input signals in slave mode.	
	DIO	75		
PCM_CLK			PCM clock, Serve as output signals in master	
			mode.Serve as input signals in slave mode.	
PCM_DIN	DI	76 PCM data input		
PCM_DOUT	DO	78	PCM data output	

The module supports 16-bit linear data format. Clock and mode can be configured, and the default configuration is primary mode using short frame sync format with 2048 kHz PCM\_CLK and 8 kHz PCM\_SYNC. For more details, see document [6].

#### Remark:

1. When using Bluetooth, PCM\_SYNC and PCM\_CLK can only be used as output signals.



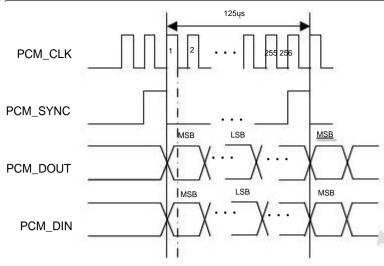


Figure 19 PCM timing diagram (Short frame synchronization)

# 3.11 PCIE Interfaces

The module provides two PCIe interface.

- ☐ The PCIe 1 interface supports RC and EP modes, works in RC mode by default
- ☐ The PCle 2 interface only supports RC mode, default for WLAN&BT module.
- ☐ The PCIe 1 Compliant with PCI Express Base Specification Revision 3.0 (2-lines) and Revision 4.0 (1-line)
- ☐ The PCle 2 Compliant with PCl Express Base Specification Revision 3.0
- $\hfill\square$  Maximum rate: 8 Gbps for PCIE gen3.0 and 16 Gbps for PCIE gen4.0
- $\ \ \square \ \ Backward \ compatible$
- ☐ Can be used to connect to an external WLAN chip or application processor

Table 12: Pin Definition of PCIe Interface

Pin name	I/O	Pin	Description	Remark
PCIE1_REFCLK_P	AIO	40	PCle1reference clock (+), Serve as output signals in RC mode. Serve as input signals in EP mode.	If PCIE_TX1 and PCIE_RX1
PCIE1_REFCLK_M	DIO	38	PCIe1reference clock (-), Serve as output signals in RC mode. Serve as input signals in EP mode.	are unused, keep these pins unconnected.
PCIE1_TX0_M	AO	44	PCIe1 transmit 0 (-)	Require differential impedance
PCIE1_TX0_P	AO	46	PCIe1 transmit 0 (+)	of 70–110 Ω, and 85 Ω is
PCIE1_TX1_M	AO	41	PCIe1 transmit 0 (-)	recommended
PCIE1_TX1_P	AO	43	PCIe1 transmit 0 (+)	
PCIE1_RX0_M	Al	32	PCIe1 receive 0 (-)	
PCIE1_RX0_P	Al	34	PCIe1 receive 0 (+)	
PCIE1_RX1_M	Al	35	PCIe1 receive 0 (-)	



PCIE1_RX1_P	Al	37	PCIe1 receive 0 (+)	
PCIE1_CLKREQ_N	DIO	36	PCIe1 clock request	Serve as input signals in RC mode. Serve as output signals in EP mode.
PCIE1_WAKE_N	DIO	30	PCIe1 wake up	Require a 100 kΩ pull-up to  VDD_EXT. 1.8 V power  domain.
PCIE1_RST_N	DO	39	PCIe1 reset	Serves as an output signal in RC mode. Serves as an input signal in EP mode.
PCIE2_REFCLK_P	AO	489	PCIe2 reference clock (+),	Only used in RC mode and serve as an output signal in RC mode.
PCIE2_REFCLK_M	AO	490	PCIe2 reference clock (-),	Require differential impedance of 72.5–97.5 $\Omega$ , and 85 $\Omega$ is recommended
PCIE2_TX_P	AO	491	PCIe2 transmit 0 (+)	Require differential impedance
PCIE2_TX_M	AO	492	PCIe2 transmit 0 (-)	of 72.5–97.5 $\Omega$ and 85 $\Omega$ is
PCIE2_RX_P	AI	487	PCIe2 receive 0 (+)	recommended
PCIE2_RX_M	AI	488	PCIe2 receive 0 (-)	
PCIE2_CLKREQ_N	DI/DO	485	PCle2 clock request	Only used in RC mode and
PCIE2WAKE_N	DI/DO	484	PCle2 wake up	serve as input signals in RC
PCIE2_RST_N	DI/DO	486	PCIe2 Reset	mode.



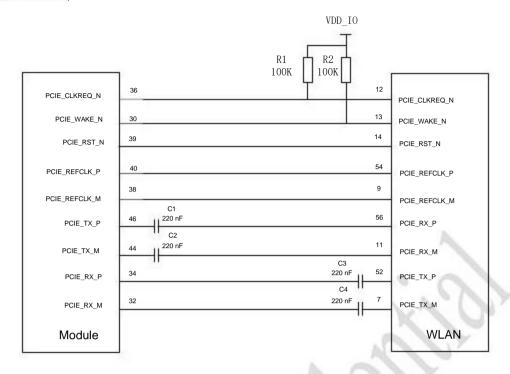


Figure 20 PCle interface reference design

To meet PCIe specifications and enhance the reliability of applications, follow the criteria below in the PCIe interface circuit design:

- It is important to route the PCle signal traces as differential pairs with ground surrounded. The differential impedance is 70–110  $\Omega$  and 85  $\Omega$  is recommended for PCle Tx/Rx/REFCLK traces.
- PCIe signals must be protected from noisy signals (clocks, DC-DC, RF and so forth). All other sensitive/high-speed signals and circuits must be routed far away from PCIe traces.
- ☐ For each differential pair, the intra-lane length match should be less than 0.7 mm, while the inter-lane
- Ilength match, that is, the trace length matching between the Tx, Rx and reference clock pairs is not required. Do not stagger the capacitors, as this can affect the differential integrity of the design and can create EMI.
- ☐ To reduce the probability for layer-to-layer manufacturing variation, minimize layer transitions for the main route on the PCB (that is, apply layer transitions only at break in and break out regions). When the differential signal traces changes layers, create ground vias near signal vias, and create at least 1–3 ground vias for each differential pair.
- Avoid bending of the traces to avoid common mode noise to the system. When bending is required, maintain a bend angle greater than 135°as shown in the figure below, and the shortest trace caused by bending should be at least 1.5 times the trace width (1.5W). The spacing between Tx and Rx pairs, and the spacing between PCIe lanes and all other signals, should exceed 4 times the trace width (4W).



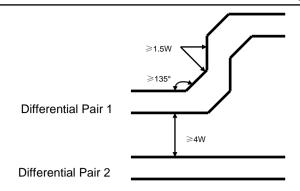


Figure 21 Schematic diagram of differential routing

PCIe Tx AC coupling capacitors can be anywhere along the line, but better to be placed close to the source or the receiver side to keep good signal integrity of main route on PCB. Use a serpentine to keep the difference pairs equal in the break out region as much as possible, to ensure that the traces stay differential thereafter. The length of each serpentine section should be at least 3 times the trace width (≥ 3W), and the maximum spacing between the serpentine section and the other differential trace should be less than twice of the normal differential trace spacing (S1 < 2S).

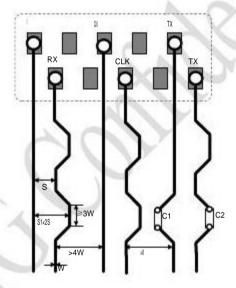


Figure 22 Schematic diagram of PCle cabling requirements

- PCle Tx AC coupling capacitors should be 220 nF.
- The maximum trace length of each differential pair for PCIe should be less than 300 mm.

## 3.12 WLAN and Bluetooth Application

The module provides one PCIe interface for WLAN function (see Chapter 4.6 for more details), and Bluetooth UART and PCM interfaces for Bluetooth function (see Chapter 4.3 and Chapter 4.5 for more details).

The following table shows the pin definition of WLAN and Bluetooth application interfaces.

Table 13: Pin Definition of WLAN and Bluetooth Application Interfaces



Pin name	I/O	Pin	Description
VDD_EXT	PO	68	Provide 1.8 V for external circuits. This pin can be used to connect with VDD_IO of Quectel WLAN module, it also can be used as power supply for external pull up circuits.
VDD_WIFI_VL	PO	274,275	0.95 V low-voltage power supply for Wi-Fi & Bluetooth modules
VDD_WIFI_VM	PO	276	1.35 V medium-voltage power supply for Wi-Fi & Bluetooth modules
VDD_WIFI_VH	PO	277	1.95 V high-voltage power supply for Wi-Fi & Bluetooth modules
Coexistence Control Interfa	ice		
COEX_UART_TXD	DO	69	LTE & WLAN & Bluetooth UART coexistence transmit
COEX_UART_RXD	DI	67	LTE & WLAN & Bluetooth UART coexistence receive
Others Interfaces			
WLAN_PWR_EN1	DO	222	WLAN power supply enable control 1.Used for Quectel AF50T VDD_RF power control.
WLAN_EN	DO	228	WLAN function enable control
BT_EN	DO	66	Bluetooth enable control
HOST_SW_CTRL	DI	184	Switch control
WLAN_SLP_CLK	DO	231	WLAN 32 kHz sleep clock.If unused, keep it open.

#### Remark:

When WLAN or Bluetooth function is intended to be used, the coexistence UART interface must be used simultaneously. The coexistence UART interface cannot be used as general-purpose UART interface.

The following figure shows a reference design of WLAN and Bluetooth application interfaces. For more details, see document [7].



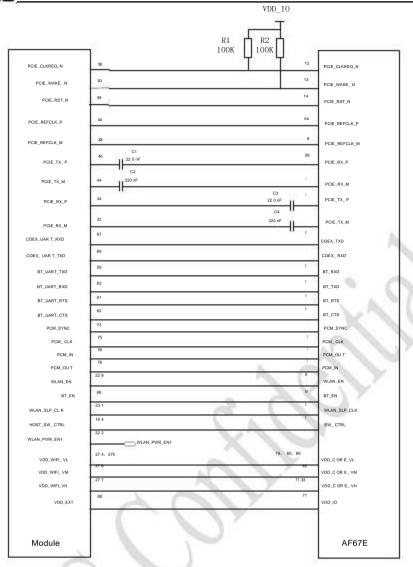


Figure 23 WLAN and Bluetooth Application interface Reference design (AF67E)

## 3.13 SDIO Interfaces

The module provides two SDIO interfaces: SDIO1 can be used for eMMC functions; SDIO2 can be used to connect external SD cards or DSRC modules.

The following table shows the pin definitions for the SDIO interface.

Table 14: Pin Definition of SDIO Interface

Pin name	1/0	Pin	Description
SDIO1_DATA_0	DIO	49	SDIO1data bit 0
SDIO1_DATA_1	DIO	50	SDIO1data bit 1
SDIO1_DATA_2	DIO	51	SDIO1data bit 2
SDIO1_DATA_3	DIO	52	SDIO1data bit 3
SDIO1_CMD	DIO	48	SDIO1 command



No. 10 Control of the			
SDIO1_CLK	DO	47	SDIO1 clock
SDIO1_DS	DIO	57	SDIO1_DS
SDIO1_DATA_4	DIO	53	SDIO1data bit 4
SDIO1_DATA_5	DIO	55	SDIO1data bit 5
SDIO1_DATA_6	DIO	56	SDIO1data bit 6
SDIO1_DATA_7	DIO	58	SDIO1data bit 7
SDIO2_DATA_0	DIO	1	SDIO2 data bit 0
SDIO2_DATA_1	DIO	2	SDIO2 data bit 1
SDIO2_DATA_2	DIO	4	SDIO2 data bit 2
SDIO2_DATA_3	DIO	5	SDIO2 data bit 3
SDIO2_CMD	AO	269	SDIO2 command
SDIO2_CLK	AO	270	SDIO2 clock
SDIO2_DS	DIO	3	SDIO2_DS
	•	•	

## 3.13.1 Reference Design for eMMC Application

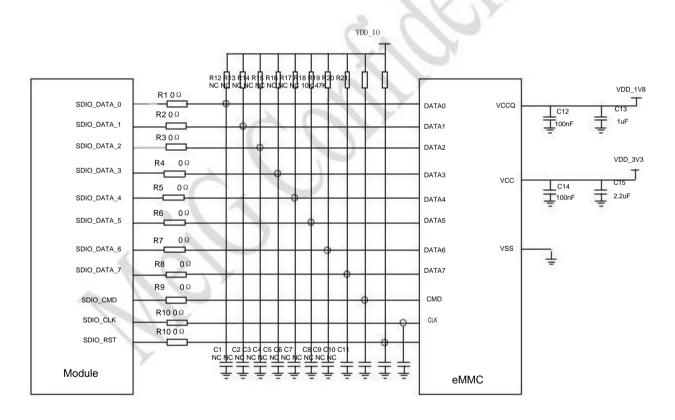


Figure 24 Reference design for eMMC application

Follow the principles below in eMMC circuit design:

To avoid jitter of bus, it is recommended to reserve R12–R19 (10–100 kΩ) to pull up SDIO signals to an external 1.8 V VDD. The resistors are not mounted by default, and the recommended value is 100 kΩ.



- To improve signal quality, it is recommended to add resistors R1–R10 in series between the module and eMMC. Resistor R10 should be 20–30  $\Omega$  and the other resistors are 0  $\Omega$  by default. The bypass capacitors C1–11 are reserved and not mounted by default. All resistors and bypass capacitors should be placed close to the module.
- It is important to route the SDIO signal traces with total grounding. The impedance of SDIO data trace is 50  $\Omega$  (±10 %).
- Keep SDIO signals far away from other sensitive circuits/signals such as RF circuits, analog signals, etc., as well as noisy signals such as clock signals, DC-DC signals, etc.
- It is recommended to keep the trace length difference between SDIO\_CLK and SDIO\_DATA[0:7]/SDIO\_CMD less than 1 mm and the total routing length less than 50 mm. The total trace length inside the module is 17 mm, so the exterior total trace length should be less than 33 mm.
- Keep the spacing between SDIO and other signal traces at least twice the trace width and the load capacitance of SDIO bus less than 30 pF.

#### 3.14 SPI Interfaces

The module provides two SPI interfaces by default. The maximum clock frequency is up to 50 MHz. The following tables show the pin definition of SPI interfaces. The two SPI interfaces are in the 1.8V power domain and supports SPI Master and Slave mode.

Table 15: Pin Definition of SPI Interfaces.

Pin name	1/0	Pin	Description	
SPI1_CLK	DIO	216	SPI1clock	
SPI1_CS	DIO	213	SPI1 chip select	
SPI1_MISO	DIO	219	SPI1 master-in slave-out	
SPI1_MOSI	DIO	210	SPI1 master-out slave-in	
SPI2_CLK	DIO	103	SPI2 clock	
SPI2_CS	DIO	105	SPI2 chip select	
SPI2_MISO	DIO	106	SPI2 master-in slave-out	
SPI2_MOSI	DIO	108	SPI2 master-out slave-in	

The following figure shows the timing relationship of SPI interface.

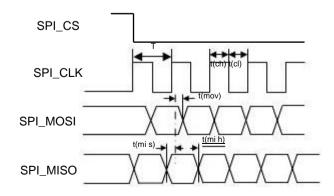


Figure 25 SPI Timing



The related parameters of SPI timing are shown in the table below.

Table 16: Parameters of SPI Interface Timing

Pin name	I/O	Pin	Description	Remark
ETH_MDIO	DIO	10	Ethernet management data	It generally requires a pull-up resistor close to the external PHY end.
ETH_MDC	DO	11	Ethernet management	Do not add any pull-up resistor to this pin, or it may cause higher
NOTE:			clock	current consumption during sleep

module and the	ie nost ii the application is equipped wit	n a s.s v processor	or device interrace	100	
Parameter	Description	Min.	Тур.	Max.	Unit
Т	SPI clock period		YO,		ns
5°.115 RG	Michtierraces time	C.A.	1	-	ns
t(cl)	SPI clock low-level time	X '	10.	-	ns
t(mev)module	esippolyglesmasterinte@grateplaytputEtherne	et MAC with a RGM	III interface which a	lso supports EAV	B. ns
t(mijs)feature	nefacimiaataaintadaaesetahqiimebelow		W -	-	ns
t(mih) 5	SPI master data input hold time compliant	(1)r.	-	-	ns
□ Supports	s 10/100/1000 Mbps operation				
☐ Supports	s protocols such as IEEE 1722.A (AVTP	), 802.1Qav (FQTS	S), 802.1Qat (SRP	), 802.1AS	
(aDTD)					

- Support connecting to an external Ethernet PHY or switch
- ☐ Support 1.8 I/O standards

The following table shows the pin definition of RGMII interface.

Table 17: Pin Definition of RGMII Interface

Pin name	1/0	Pin	Description	Remark
ETH_MDIO	DIO	10	Ethernet management data	It generally requires a pull-up resistor close to the external PHY end.
ETH_MDC	DO	11	Ethernet management clock	Do not add any pull-up resistor to this pin, or it may cause higher current consumption during sleep mode.
ETH_PWR_EN	D0	27	Enable external power	

Parameter	Description	Min.	Тур.	Max.	Unit
MeiG Smart Te	chnology Co., Ltd.				77/119
Т	SPI clock period		-	-	ns
t(ch)	SPI clock high-level time		-	-	ns



	l .			Ī
			supply to power Ethernet PHY	
ETH_INT	DI	29	Ethernet PHY interrupt input	
ETH_RST	DO	31	Reset output for Ethernet PHY	
RGMII_CK_RX	DI	19	RGMII receive clock	
RGMII_CTL_RX	DI	15	RGMII receive control	
RGMII_RX_0	DI	13	RGMII receive data bit 0	
RGMII_RX_1	DI	14	RGMII receive data bit 1	The single-ended impedance
RGMII_RX_2	DI	16	RGMII receive data bit 2	
RGMII_RX_3	DI	17	RGMII receive data bit 3	
RGMII_CK_TX	DO	24	RGMII transmit clock	requires 50 Ω.
RGMII_CTL_TX	DO	21	RGMII transmit control	
RGMII_TX_0	DO	20	RGMII transmit data bit 0	
RGMII_TX_1	DO	22	RGMII transmit data bit 1	
RGMII_TX_2	DO	23	RGMII transmit data bit 2	
RGMII_TX_3	DO	25	RGMII transmit data bit 3	

The following figure shows the simplified block diagram for Ethernet application.

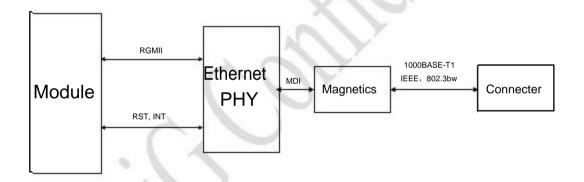


Figure 26Simplified block diagram of automotive Ethernet application

The following is the RGMII interface reference design for the PHY application.



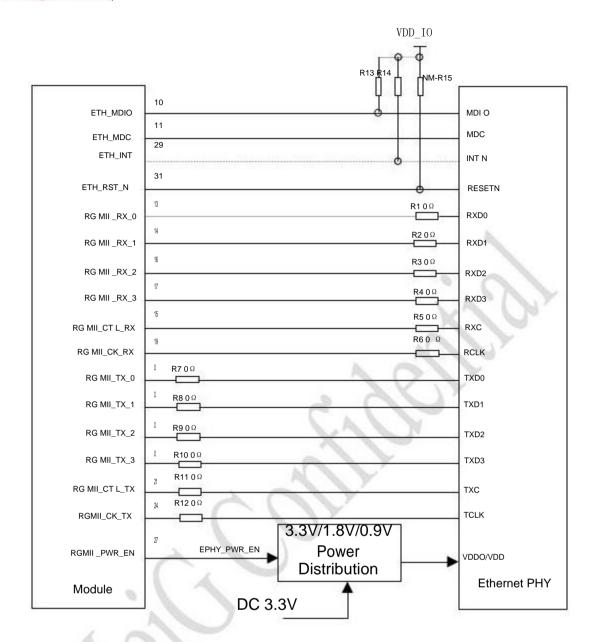


Figure 27 RGMII interface and PHY application reference circuit

To enhance the reliability and availability of application designs, follow the criteria below in the Ethernet

- Keep RGMII data and control signals away from other sensitive circuits/signals such as RF circuits, analog signals, etc., as well as noisy signals such as clock signals, DC-DC signals, etc.
- $\square$  The single-ended impedance of RGMII data traces is 50  $\Omega$  ±20 %.
- The length matching between Tx signals (RGMII\_CK\_TX, RGMII\_CTL\_TX and RGMII\_TX\_[0:3]) or Rx signals (RGMII\_CK\_RX, RGMII\_CTL\_RX and RGMII\_RX\_[0:3]) is less than 2 mm.
- ☐ Keep the spacing between Tx bus traces (RGMII\_CK\_TX to RGMII\_TX\_[0:3]/RGMII\_CTL\_TX) or that between Rx bus traces (RGMII\_CK\_RX to RGMII\_RX\_[0:3]/RGMII\_CTL\_RX) at least 2 times thetrace width.
- Keep the spacing between Tx bus and Rx bus traces at least 2 times trace width.
- ☐ Keep the spacing between RGMII and other signal traces at least 3 times trace width.

PHY circuit design:



- Resistors R7–R12 should be placed near the module. Resistors R1–R6 should be placed near the Ethernet PHY. The value of R1–R15 varies with the selection of PHY.
- ☐ RGMII\_INT and RGMII\_RST\_N are always 1.8 V power domain. A voltage-level translator should be used when the module I/O level does not match with PHY.

## 3.16 SGMI Interfaces

The module includes an integrated Ethernet MAC with a SGMII interface. Key features of the SGMII

interface are shown below:

- ☐ Supports 1000/2500 Mbps operation
- RGMII and SGMII can not operate concurrently

Table 18: Pin Definition of SGMII Interface

Pin name	I/O	Pin	Description	Remark
ETH_MDIO	DIO	10	Ethernet management data	It generally requires a pull-up resistor close to the external PHY end.
ETH_MDC	DO	11	Ethernet management clock	Do not add any pull-up resistor to this pin, or it may cause higher current consumption during sleep mode.
ETH_PWR_EN	D0	27	Enable external power supply to power Ethernet PHY	
ETH_INT	DI	29	Ethernet PHY interrupt input	
ETH_RST	DO	31	Reset output for Ethernet PHY	
RGMII_TX_P	DO	94	RGMII transmit(+)	
RGMII_TX_M	DO	96	RGMII transmit(-)	Require differential impedance of
RGMII_RX_P	DI	97	RGMII receive(+)	70– $100$ Ω, and $90$ Ωis recommended.
RGMII_RX_M	DI	99	RGMII receive(-)	

The following figure shows the simplified block diagram for Ethernet application.



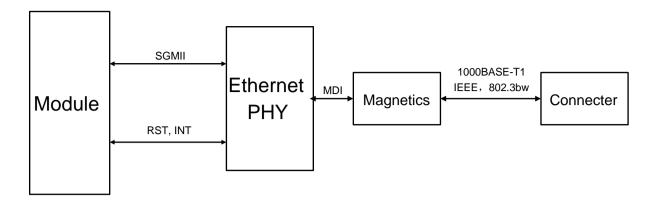


Figure 28 Simplified block diagram of automotive Ethernet application

The following figure shows a reference design of SGMII interface with PHY application. For more details, see document.

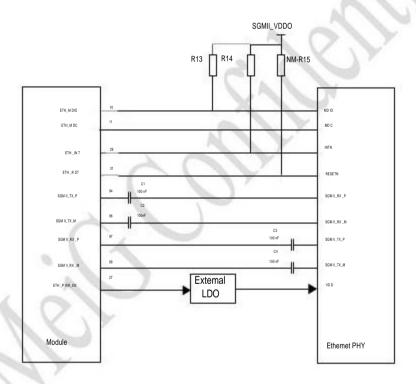


Figure 29 SGMII interface and PHY application reference circuit

To enhance the reliability and availability of application designs, follow the criteria below in the Ethernet PHY circuit design:

- It is important to route the SGMII signal traces as differential pairs with ground surrounded. The differential impedance is 70–100  $\Omega$  and 90  $\Omega$  is recommended for SGMII Tx/Rx traces.
- ☐ SGMII signals must be protected from noisy signals (clocks, DC-DC, RF and so forth). All other sensitive/high-speed signals and circuits must be routed far away from SGMII traces.



- ☐ For each differential pair, the intra-lane length match should be less than 0.7 mm, while the inter-lane length match, that is, the trace length matching between the Tx, Rx and reference clock pairs is not required.
- The spacing between Tx and Rx pairs, and the spacing between SGMII lanes and all other signals, should exceed 4 times the trace width (4W).

#### 3.17 RTC

The module has a real time clock within the PMIC, but has no dedicated RTC power supply pin. The RTC is powered by VBAT\_BB. If VBAT\_BB is removed, the RTC will not maintain. If RTC is needed, then VBAT\_BB must be powered.

## **3.18 DR SYNC**

The module obtains time through GNSS positioning and outputs 1PPS signal for clock synchronization. The DR\_SYNC pin usually connects to an external AP and a MCU to maintain the local time consistency between the three.

Table 19: Pin Definition of DR\_SYNC Interface

Pin name	1/0	Pin	Description
DR_SYNC	DO	95	Dead reckoning sync

A reference design of DR\_SYNC interface for clock synchronization application is shown as below:

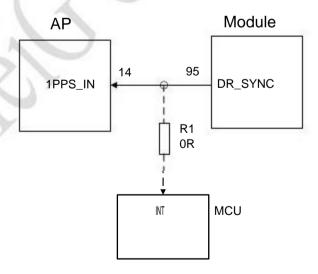


Figure 30 DR SYNC clock synchronization application reference design

#### Remark:

Pay attention to the level matching of the signal shown in dotted line between the module and the MCU.



## 3.19 IMU Interrupt Interfaces

The module realizes DR (dead-reckoning) function through an external IMU (inertial measurement unit). For more details about QDR, see document [9].

Table 20: Pin Definition of IMU Interrupt Interface

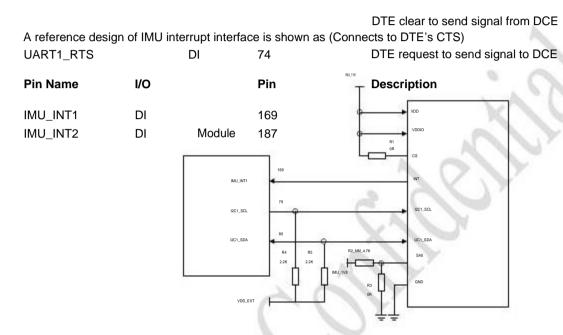


Figure 31 IMU reference design circuit

#### 3.20 UART Interfaces

The MA922 module has 5 serial ports:UART1,UART2,UART3,UART4 and debug UART.

The main features of the main serial port and debug serial port are described below.

- ☐ The main serial port supports 4800bps, 9600bps, 19200bps, 38400bps, 57600bps, 115200bps, 230400bps, 460800bps, 921600bps baud rate, the default baud rate is 115200bps, used for data transmission and AT command transmission.
- ☐ The debugging serial port supports 115200bps baud rate for R&D debugging.

Table 21 Main serial port pin description

Pin name	1/0	Pin	Description
UART1_TXD	DO	70	Module sends data
UART1_RXD	DI	72	Module accepts data
UART1_CTS	DO	71	DTE clear to send signal from DCE (Connects to DTE's CTS)
UART1_RTS	DI	74	DTE request to send signal to DCE

Pin Name I/O MeiG Smart Technology Co., Ltd.		Pin	Description	83/119
IMU_INT1	DI	169	IMU interrupt signal, suspended if not used.	
IMU_INT2	DI	187	IMU interrupt signal, suspended if not used.	

Pin name	1/0	Pin	Description
UART1_TXD	DO	70	Module sends data
UART1_RXD	DI	72	Module accepts data

UART1\_CTS DO 71

below:

#### IAM-20680HT

IMU interrupt signal, suspended if not used. IMU interrupt signal, suspended if not used.

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RI



			(Connects to DTE's RTS)	
UART2_TXD	DO	59	Module sends data	
UART2_RXD	DI	63	Module accepts data	
UART2_CTS	DO	62	DTE clear to send signal from DCE (Connects to DTE's CTS)	
UART2_RTS	DI	61	DTE request to send signal to DCE (Connects to DTE's RTS)	
UART3_TXD	DO	298	Module sends data	
UART3_RXD	DI	297	Module accepts data	
UART4_TXD	DO	296	Module sends data	
UART4_RXD	DI	295	Module accepts data	
DBG_TXD	DO	107	Module sends data, It is recommended to reserve test points for debug UART	
DBG_RXD	DI	110	Module accepts data.It is recommended to reserve test points for debug UART	

Parameter Minimum Table 22 Serial port logic levels			laximum value Unit			
VIL_	-0.3		(Connects to DTE's RTS)			
V H UART2_TXD	1.2 DO	59	V Module sends data			
VOL UART2_RXD	Bı	63	Module accepts data			
VOH_ UART2_CTS	1.35 DO	62	DTE clear to send signal from DCE (Connects to DTE's CTS)			
UART2_RTS	DI	61	DTE request to send signal to DCE (Connects to DTE's RTS)			
equipped with a 3.3 V UART UART4_TXD DO	The module provides 1.8 V UART interfaces. Use a voltage-level translator if your application is UART3_RXD DI 297 Module accepts data equipped with a 3.3 V UART interface. The following figure shows a reference design. It is					
DBG_TXD	DO	107	Module sends data, It is recommended to —reserve test points for debug UART			
DBG <sub>V</sub> RXD18	DI	110VCCA	Module accepts data.It is recommended to VDD_MCU			
Parameter	Minimum	OE <b>N</b>	Ոaximum value 0. 1uF Unit			

0.6

Pranslator B

Figure 32 Level conversion chip reference circuit

B3 0.45 B4 B5 1.8 B6 B7 B8

Another level shifting circuit is shown in the figure below. The input and output circuit design of the dotted line part below can refer to the solid line part, but pay attention to the connection direction. At the same time, this level conversion circuit is not suitable for applications with baud rate exceeding 460Kbps.

0. 1uF -0.3

1.2

0

1.35

 $VIL_{-}$ 

V IH

VOL\_

VOH



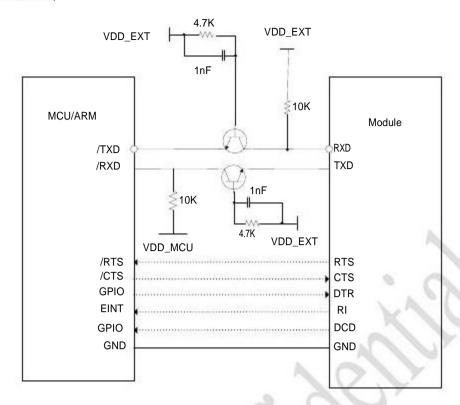


Figure 33 UART signal connection 2

#### Remark:

When designing, it is recommended to reserve 0R resistors and parallel capacitors on the main serial port and debug serial port lines, which can be added on the bottom plate to prevent RF interference.



#### 3.21 Low Power Mode

#### 3.21.1 Flight Mode

The MA922 module supports entry into airplane mode:

Table 23: Airplane mode Settings description

1 AT command control	AT+CFUN=4Enter airplane mode AT+CFUN=1Enter normal mode
----------------------	---

### 3.21.2 Sleep Mode

The module can activate sleep mode in the following ways:

AT to be determined

#### 3.21.3 Ultra-low Power ModeT

Use the following AT instructions to put the module into ultra-low power mode (can be used for power testing)

AT to be determined

#### 3.22 ADC Function

The module provides two analog-to-digital converter (ADC) interfaces. To improve the accuracy of ADC, the traces of ADC interfaces should be surrounded by ground.

Table 24 ADC pin description

Pin name	1/0	Pin	Description
ADC0	1	247	Voltage range:0–1.875 V
ADC1	1	245	Totage range of more t
ADC2	1	113	

#### Remark:

- 1. The input voltage for each ADC interface must not exceed its corresponding voltage range.
- 2. It is prohibited to supply any voltage to ADC pins when VBAT is removed.
- 3. It is recommended to use resistor divider circuit for ADC application.

## 3.23 USB\_BOOT Interface

MA922 supports USB\_BOOT function . Customers can short- circuit USB\_BOOT and VDD\_EXT before



the module is turned on, and the module will enter the forced download mode when the module is turned on. In this mode, the module can be upgraded through the USB interface.

Table 25 USB\_BOOT pin definition

Pin name	1/0	Pin	Description
USB_BOOT	DI	83	It is recommended to reserve test points.
VDD_EXT	PO	68	it to recommended to reserve test points.



# MEIG 美格 4. Antenna Interfaces

The MA922 module is designed with three antenna interfaces, and the impedance of the antenna interface is  $50\Omega$ .

Table 26 Antenna interface pin definition

Pin name	Pin number	Description	1/0	Remark
ANT_MAIN	49	main antenna interface	Ю	50Ω impedance
BT_ANT	35	WIFI/BT antenna interface	Ю	50Ω impedance
ANT_GNSS	47	GPS antenna interface	Ю	50Ω impedance



## 4.1 Introduction of Antenna Interface

MA922 provides three antenna pins: ANT\_MAIN, BT-ANT, ANT\_GNSS to improve the TDD-LTE/ FDD-LTE, WIFI/BT, GNSS transceiver performance of the product. It is recommended that users use an antenna with an impedance of  $50\Omega$  that matches the RF connector on the module end.

#### Remark:

To ensure communication capability in all frequency bands, please connect all antennas .

It is recommended that the RF adapter cable be carefully selected on the application side. It is necessary to choose an RF patch cord with as little loss as possible. It is recommended to use RF patch cables with the following RF loss requirements:

- ☐ GSM900 < 0.6 dB;
- DCS1800 < 1.0 dB;</p>
- □ TDD- LTE< 1.2dB;</p>
- ☐ FDD-LTE < 1.2dB;</p>
- ☐ WIFI/BT<1.2dB;
- ☐ GNSS<1.0dB.

#### The RF Connectors are recommended:

Product name		MHF ILK	MHF	MHF I	MHFIII		
Appgarano		1/4	20	3	-		
Appea drue		MHF Lwith mechanical lock	Best Insertion Loss	Most Cable C Di options	low profile 1.60mm		
Plug part nun	niper	2	20767-001R	20279-112R-++	20600-002R		
Receptacle parti	number		20369-0015-++				
Maximun heigh	i (mm)	2.0	3.0	2.5	1.6		
Outside dimension of re	eceptacie(mm)	A10.5	30×30		20×20		
	2:00 mm(26)		•				
	1.80 mm(30)	•		•			
1	1.37 mm(30)	•		•			
	1.32 mm(32)	•	į.	•			
Coax C.D.	1.13 mm(32)	•					
(Center Conductor AWG)	0.95 mm(23)	1534.5					
	0.81mm (33)						
	0.81 mm(36)	•	2	•	•		
	0.64 mm(36)				•		
	0.48 mm(38)						
Frequency	1		DC - 8GHz				
	DC-3GHz	1:	13 max (PLUG)/13 max (RECE)				
	3GHz-6GHz	2.0	1.5 max.(PEUG)/1.4 max.(RECE)				
VSWR (L=100mm)	6GHz-9GHz	1.0 max (PLUG)/	1.6 max(PLUG)/1.5 max(RECE) 1.6 max(PLUG) 1.8 max(RECE)				
	0GHz-12GHz						
	12GHz-15GHz						
Service temp (C	'elsius)	-40 degree - 90degree					
Characteristic Imp	pedance	50ohm					
Rated voltage		AC60V					
Contact regist	ance	20m ohm max					
Withstand vol	tage		AC200V/min				
Insulation resistance		500M ohm min/DC100V					

Figure 34. The RF Connector



#### 4.2 RF Reference Circuit

#### 4.2.1 Antenna Connection Reference Design

The SDR0\_ANT0, SDR0\_ANT1, SDR0\_ANT2, SDR0\_ANT3, CV2X\_ANT5, CV2X\_ANT6, SDR\_GNSS\_ANT4 antenna connection reference design circuit is shown in the figure below. In order to obtain better RF performance, the following four points should be paid attention to in schematic design and PCB layout:

- 1. Schematic design, a  $\pi$ -type matching circuit is reserved near the RF port of the module, and the capacitor is not pasted by default;
- 2. Schematic design, redundant RF connectors between the module RF port and the antenna are used for certification testing, and the RF connectors may not be attached after mass production and delivery; (Reference: RF Connector-1P-H176);
- 3. Schematic design, a  $\pi$ -type matching circuit is reserved near the antenna end, and the capacitor is not pasted by default;
- 4. PCB layout, the wiring between the module RF port and the antenna is as short as possible, and the board factory needs to do  $50\Omega$  impedance control on the RF wiring.

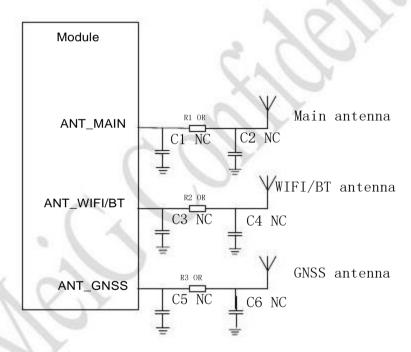


Figure 35 RF Reference Circuit

#### 4.2.2 RF Signal Line Layout

For the user PCB, the characteristic impedance of all the RF signal lines shall be controlled at 50  $\Omega$ . Generally, the impedance of the RF signal line is determined by the dielectric constant of the material, the wiring width (W), the ground gap (S), and the height (H) of the reference ground plane. The control of PCB property impedance usually adopts microband line and coplanar waveguide. To reflect the design principles, the following pictures show the structural design of the microstrip line and the coplanar waveguide when the impedance line controls the  $50\Omega$ waveguide.

W1: Maximum line width W2: minimum line width T1: copper thickness H1: plate medium thickness ERI: plate dielectric constant.

Microband line complete structure



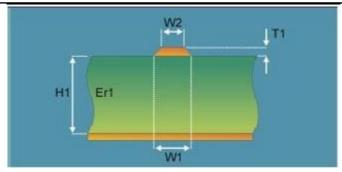


Figure 36 Microband line structure of two-layer PCB plates

Complete structure of the coplanar waveguide

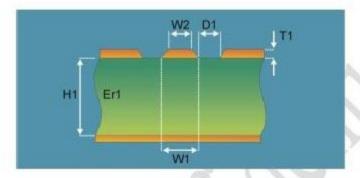


Figure 37 Co-planar waveguide structure of two-layer PCB plates

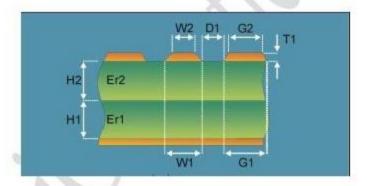


Figure 38 Multi-layer PCB board common-planar waveguide structure (reference for the third layer)

In the circuit design of RF antenna interface, the following design principles are recommended to ensure the good design and reliability of RF signal:

- $\ \square$  Precise 50  $\ \Omega$  impedance control of the RF signal lines shall be performed using impedance simulation calculation tools.
  - GND pins adjacent to RF pins do not make hot pads and make full contact with the ground.
- ☐ The distance between the RF pin and the RF connector should be as short as possible; also avoid a recommended alignment angle of 135.
- ☐ When the connection device package is established, the signal foot should keep a certain distance from the ground.
- ☐ The ground plane of the RF signal line reference shall be complete; adding a certain amount of ground holes around the signal line and the reference ground may help improve the RF



performance; the distance between the ground hole and the signal line shall be at least 2 times the line width (2 W).

☐ RF signal lines must be away from interference sources and avoid crossing or parallel to any signal lines in adjacent layers.

## 4.3 Antenna installation

#### 4.3.1 Antenna Requirements

Antenna The requirements for the receiving antenna are shown in the table below:

Table 27 Antenna requirements

Туре	Requirement				
	VSWR: < 2				
	Gain (dBi): 1				
0004/TDD   TE/FDD   TE/AID	Maximum input power (W): 2W				
GSM/TDD-LTE/FDD-LTE/NR	Input Impedance (ohm): 50				
	Polarization Type: Vertical				
	Cable insertion loss: < 1.5dB				
	(GSM 900 / 18 00 ; LTE B 1 /B 3 /B 5 /B 8 /B 34 / B39 )				
	Cable Insertion Loss: < 2dB				
	(LTE B38/B40/B41)				
	Frequency range: 5855–5925 MHz				
	Gain: Min. 4 dBi				
	VSWR: ≤ 2				
C-V2X	efficiency: > 30 %				
	Maximum output power: 10 W				
	Recommended antenna pattern: ±10–15°(Azimuth Beamwidth:				
	360°				
	Elevation beamwidth: ±10–15°)				
	Input Impedance (ohm): 50 Ω				
	Cable insertion loss:				
	< 2 dB: C-V2X TDD B47				
	VSWR: < 2				
CNICC	Gain (dBi): 1				
GNSS	Maximum input power (W): 0.1 W				
	Input Impedance (ohm): 50				
	Polarization Type: Vertical				
	Cable insertion loss: < 1.5dB				

## 4.3.2 RF Output Power

The RF output power of the MA922 is shown in the table below.



Table 28 MA922 RF transmit power

Frequency	Receiving Sensitivity (Typical BW ) -10M				
	Main episode	Separation	Main episode + Diversity	3GPP (Main + Diversity)	
EGSM900	-108dBm	NA	NA	-102.4dBm	
DCS1800	-108dBm	NA	NA	-102.4dBm	
LTE-FDD B1	-97dBm	NA	NA	-96.3dBm	
LTE-FDD B3	-97dBm	NA	NA	-93.3dBm	
LTE-FDD B5	-98dBm	NA	NA	-94.3dBm	
LTE-FDD B8	-98dBm	NA	NA	-93.3dBm	
LTE-FDD B28A	-98dBm	NA	NA	-93.3dBm	
LTE-TDD B34	-97.5dBm	NA	NA	-96.3dBm	
LTE-TDD B38	-97.5dBm	NA	NA	-96.3dBm	
LTE-TDD B38 <b>1.3.3 RF Receiv</b> LTE-TDD B39	-97.5dBm	NA	NA	-96.3dBm	
LTE-TDD B492 mod	-97.5dBm NA Jule RF receiving sen	sitivity	NA	-96.3dBm	
LTE-TDD B41	-97.5dBm	NA	NA	-94.3dBm	

-37.3dDIII	INA	14/1	* 11.**			
WCDMA B1 -106.7 NA Receiving Sensitivity (Typical BW) -10M						
		-103.7				
Main episode	NA Separation	Main episode + NA Diversity	3GPP (Main + -95.8 Diversity)			
-108dBm	NA	NA	-102.4dBm			
-108dBm	NA	NA	-102.4dBm			
-97dBm	NA	NA	-96.3dBm			
-97dBm	NA	NA	-93.3dBm			
-98dBm	NA	NA	-94.3dBm			
-98dBm	NA	NA	-93.3dBm			
-98dBm	NA	NA	-93.3dBm			
-97.5dBm	NA <b>value</b>	NA <b>Minimum</b>	-96.3dBm			
-97.5dBm	NA	NA 5dBm+5dB	-96.3dBm			
-97.5dBm	NA	NA 0dBm+5dB	-96.3dBm			
-97.5dBm	NA	NA	-96.3dBm			
-97.5dBm	NA ±2 dB (Class 3)	NA WCDMA	-94.3dBm			
-106.7	NA	NA	-106.7			
-106.7	NA	NA	-103.7			
-95.8	dBm ±2 dB (Class 3)	NA < -40 dBm	-95.8			
-92.8	NA	NA	-92.8			
-92.8 26	dBmNA +1/-2 dB (Class	2)NA < -40 dBm	-92.8			
-90.1	NA	NA	-90.1			
-86.7	NA	NA	-86.7			
-86.8	NA	NA	-86.8			
-86.8	NA	NA	-86.8			
-86.3	NA	NA	-86.3			
	-106.7 N Main episode  -108dBm -108dBm -97dBm -97dBm -98dBm -98dBm -98dBm -97.5dBm -97.5dBm -97.5dBm -97.5dBm -97.5dBm -92.8 -92.8 -92.8 -92.8 -90.1 -86.7 -86.8	Main episode         NA NA Separation           -108dBm         NA           -108dBm         NA           -97dBm         NA           -97dBm         NA           -98dBm         NA           -98dBm         NA           -97.5dBm         NA           -90.7         NA           -90.7         NA           -92.8         26           dBmNA +1/-2 dB (Class           -90.1         NA           -86.7	Receiving Sensitivity (Typical BW ) -10M           -106 7         NA         NA         -103 7           #ain episode         Separation         Main episode + Diversity           -108dBm         NA         NA           -108dBm         NA         NA           -97dBm         NA         NA           -97dBm         NA         NA           -98dBm         NA         NA           -98dBm         NA         NA           -98dBm         NA         NA           -97.5dBm         NA         NA           -90.1         NA         NA           -90.8         23 dBm ±2 dB (Class 3)         NA           -95.8         NA         NA           -92.8         NA         NA           -90.1         NA         NA           -86.8			

Frequency Maximum value Minimum Remark:

EGSIMMONT mation on other sub-months/addlerne/dB bands/will-be/fdBm±5dBsubsequent editions of the

DCS1800 30dBm±2dB 0dBm±5dB

Wei Sin Mart Technology Co., Ltd. 23 dBm ±2 dB (Class 3) WCDMA 93/120



## **4.3.4 Operating Frequency**

Table 30 MA922 operating frequency

3GPP frequency band	Send	Take over	Unit
EGSM900	880~915	925~960	MHz
DCS1800	1710~1785	1805~1880	MHz
WCDMA B1	1920–1980	2110–2170	MHz
WCDMA B8	880–915	925–960	MHz
LTE-FDD B1	1920~1980	2110~2170	MHz
LTE-FDD B3	1710~1785	1805~1880	MHz
LTE-FDD B5	824~849	869~894	MHz
LTE-FDD B8	880~915	925~960	MHz
LTE-FDD B28A	703–733	758–788	MHz
LTE-TDD B34	2010~2025	2010~2025	MHz
LTE-TDD B38	2570~2620	2570~2620	MHz
LTE-TDD B39	1880~1920	1880~1920	MHz
LTE-TDD B40	2300~2400	2300~2400	MHz
LTE-TDD B41	2555~2655	2555~2655	MHz
C-V2X B47	5855–5925	5855–5925	MHZ
5G NR FDD n1	1920–1980	2110–2170	MHZ
5G NR FDD n3	1710~1785	1805~1880	MHZ
5G NR FDD n8	880~915	925~960	MHZ
5G NR FDD n28A	703–733	758–788	MHZ
5G NR FDD n41	2496–2690	2496–2690	MHZ
5G NR FDD n77	3300–4200	3300–4200	MHZ
5G NR FDD n78	3300–3800	3300–3800	MHZ
5G NR FDD n79	4400–5000	4400–5000	MHZ
GPS	/	L1:1575.42±1	MHZ
J. J	,	L5: 1176.45±1	
BDS	1	1559~1563	MHZ
Glonass	1	1597~1606	MHZ



## 5. Electrical Characteristics

## 5.1 Limited Voltage Range

The limit voltage range refers to the module power supply voltage and the maximum voltage range that the digital and analog input/output interfaces can withstand. Working outside this range may result in damage to the product.

The limit voltage range of MA922 is shown in the table below.

Table 31 The limit working voltage range of the module

Parameter	Description	Minimum	Typical value	Maximum value	Unit
VBAT_BB, VBAT_RF	VBAT_BB and VBAT_RF	-0.3	3.8	6.0	V
USB_VBUS	USB connection detect	-0.3	5.0	5.5	V
VBAT_CV2X	Power supply for the module's C-V2X part	-0.5	5.0	5.3	V
Voltage at Digital Pins	Digital I/O supply voltage	-0.3		2.13	V
Voltage at ADC0		0		4.8	V
Voltage at ADC1		0		4.8	<b>V</b>

parameter	minimum	Typical value	maximum value	unit
Operating temperature		Dongo	+75	°C
5d2nded Ambient	-40 -40	Range	+ 85	°C

MA922 module is recommended to work in the environment of -30~+70 °C oft is recommended that the application side consider temperature control measures under harsh environmental conditions. At the same time, the extended operating temperature range of the module is provided. When used under extended temperature, the function is normal, but some RF indicators may deteriorate. At the same time, it is recommended that the module application terminal be stored under certain temperature conditions. Modules beyond this range may not work properly or may be damaged.

Table 32 Module temperature range

Parameter	Description	Minimum	Typical value	Maximum value	Unit
VBAT_BB, VBAT_RF	VBAT_BB and VBAT_RF	-0.3	3.8	6.0	V
USB_VBUS	USB connection detect	-0.3	5.0	5.5	V
WeiGTSmart Techno	ology Co.,supply for the module's C-V2X part	-0.5	5.0	5.3	V 95/120

Voltage at Digital I/O supply voltage -0.3 2.13 V



Module	Pilot	Test case	Result (mA)
state	projects	Test case	Result (IIIA)

Shutdown

5.34 Module Rower Consumption Range power supply in case of power failure

TBD

current

Table 33 Power consumption

Module state	Bottom Pilot current projects	Power on, no sim of the current value in flig	card, no T card, test the minimum  pht mode.	TBD Result (mA)
Shutdown	Shutdown leakage current	Maintain normal vo Insert the mobile c ATpowercommandfa	TBD TBD	
	Real Bottom current network		card, no T card, test the minimum nicom card, wait for the actual network, T commandin flight mode.to query and register on the	TBD TBD
	sieep	AT command to que network, use the A record the average the network, and re	ard, wait for the actual network, use the munication card, wait for the actual lery the registration on the network, and control to manard to query and register on ecurrent for 10 minutes.	TBD TBD
Hibernate	network sleep	use the AT comma	nicom card, wait for the actual network, GSM850 CH190 and to query and register on the 1) The module under test is powered on d the average current for 10 minutes.	TBD
		network, use the A	munication card, wait for the actual data network; T command to query and register on 2) The module is set to sleep state ecord the average current for 10 through AT commands (USB is in the	TBD TBD
Hibernate	GSM850 GSM850	powered on , and the USB is in a suspended state the module is  powered on , and the USB is in a	GSM850 CH190 3) The module under test remains in the 1) The module under test is powered on state of no data transmission for 10 and successfully registered with the minutes, and records Average current data network: for 10 minutes. 2) The module is set to sleep state GSM850 CH128 through AT commands (USB is in the 1) The module under test is powered on suspended state): and successfully registered with the 3) The module under test remains in the data network; state of no data transmission for 10 2) The module is set to sleep state minutes, and records Average current through AT commands (USB is in the for 10 minutes.	TBD
Temperature		suspended state	GSM850 CH128 3) The module under test remains in the 1) The module under test is powered on state of no data transmission for 10 and successfully registered with the minutes, and records Average current data network;	TBD
Storage		-40 -	2) The module is set to sleep state + 95 through AT commands (USB is in the suspended state); 3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current	

°C



	10_E 1101011	aro Booigii manaai
	for 10 minutes.	
	GSM850 CH251	
	1) The module under test is powered on	
	and successfully registered with the	
	data network;	TDD
	2) The module is set to sleep state	TBD
	through AT commands (USB is in the	
	suspended state);	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
	for 10 minutes.	
	GSM900 CH62	
	1) The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	
	(USB is suspended) through AT	
	commands;	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
GSM900	for 10 minutes.	
	GSM900 CH1	
	1) The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	
	(USB is in the suspended state) through	
	AT commands;	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
	for 10 minutes.	
	GSM900 CH124	
	1) The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	
	through AT commands (USB is in the	
	suspended state);	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
	for 10 minutes.	



		are Design Manual
	DCS CH698	
	1) The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	
	(USB is suspended) through AT	
	commands;	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
DCS	for 10 minutes.	
	DCS CH512	
	1) The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	
	(USB is suspended) through AT	
	commands;	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
	for 10 minutes.	
	DCS CH885	
	The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	100
	(USB is suspended) through AT	
	commands;	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
	for 10 minutes.	
	PCS CH661	
	The module under test is powered on	
	and successfully registered with the	
	data network;	TBD
	2) The module is set to sleep state	טטו
PCS	(USB is suspended) through AT	
	commands;	
	3) The module under test remains in the	
	state of no data transmission for 10	
	minutes, and records Average current	
	for 10 minutes.	
	PCS CH512	
	1) The module under test is powered on	TBD
	and successfully registered with the	
	data network;	



ILIO		Τ	T	T Design Manual
			2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			PCS CH810	
			1) The module under test is powered on	
			and successfully registered with the	
			data network;	TBD
			2) The module is set to sleep state	
			through AT command (USB is in the	
			suspended state);	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			Band1 CH18300	
			1) The module under test is powered on	
			and successfully registered with the	
			data network;	TBD
			2) The module is set to sleep state	
			through AT command (USB is in the	
		The module is	suspended state);	
			3) The module under test remains in the	
			state of no data transmission for 10	
	FDD	powered on,	minutes, and records Average current	
	100		for 10 minutes.	
		registered in	Band1 CH18050	
		the network idle	1) The module under test is powered on	
		state, the DRX	and successfully registered with the	
		monitoring	data network;	TBD
		period is 1.28s	2) The module is set to sleep state	1.55
		, no data	(USB is suspended) through AT	
		transmission,	commands;	
		and the USB is	3) The module under test remains in the	
		in the	state of no data transmission for 10	
		suspended	minutes, and records Average current	
		state	for 10 minutes.	
			Band1 CH18550	
			1) The module under test is powered on	
			and successfully registered with the	TBD
			data network;	100
			2) The module is set to sleep state	
			through AT command (USB is in the	
			suspended state);	
			3) The module under test remains in the	
	1	I	,	<u>I</u>



state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band3 CH19575	
The module under test is powered on      The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
through AT command (USB is in the	
suspended state);	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band3 CH19250	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
through AT command (USB is in the	
suspended state);	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band3 CH19900	
1) The module under test is powered on	
and successfully registered to the data	
network;	TBD
2) The module is set to sleep state	
(USB is suspended) through AT	
commands;	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band5 CH20525	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
through AT command (USB is in the	
suspended state);	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current for 10 minutes.	
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BandS CH20450  1) The module under test is powered on and successfully registered with the data network;  2) The module is set to sleep state  (USB is suspended) through AT commands;  3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes, and successfully registered with the data network;  2) The module under test is powered on and successfully registered with the state of no data transmission for 10 minutes.  BandS CH21660  1) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandB CH21625  1) The module under test is powered on and successfully registered with the data network;  2) The module under test is powered on and successfully registered with the data network;  2) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH21500  1) The module under test is powered on and successfully registered with the data network;  2) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH21		<del>,                                      </del>
and successfully registered with the data network;  2) The module is set to sleep state (USB is suspended) through AT commands;  3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  Bands CH20600  1) The module under test is powered on and successfully registered with the data network;  2) The module is set to sleep state (USB is suspended) through AT commands;  3) The module under test remains in the state of no data transmission for 10 minutes. Bands CH21625  1) The module under test is powered on and successfully registered with the data network;  2) The module under test is powered on and successfully registered with the data network;  2) The module is set to sleep state through AT command (USB is in the suspended state);  3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes, and records Average current for 10 minutes, and records Average current for 10 minutes.  Bands CH21500  1) The module under test is powered on and successfully registered with the data network;  2) The module is set to sleep state (USB is suspended) through AT commands;  3) The module is det to sleep state (USB is suspended) through AT commands;  3) The module under test remains in the state of no data transmission for 10 minutes. and records Average current for 10 minutes. and records Average current for 10 minutes. Bands CH217500  1) The module under test remains in the state of no data transmission for 10 minutes. Bands CH217500  1) The module under test respective on and successfully registered with the	Band5 CH20450	
data network; 2) The module is set to sleep state (USB is suspended) through AT commands; 3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH20600 1) The module under test is powered on and successfully registered with the data network; 2) The module is set to sleep state (USB is suspended) through AT commands; 3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH21625 1) The module under test is powered on and successfully registered with the data network; 2) The module is set to sleep state through AT command (USB is in the suspended state); 3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH21500 1) The module under test is powered on and successfully registered with the data network; 2) The module is set to sleep state (USB is suspended) through AT commands; 3) The module under test is powered on and successfully registered with the data network; 2) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH21750 1) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  BandS CH21750 1) The module under test is powered on and successfully registered with the	1) The module under test is powered on	
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2) The module is set to sleep state (USB is suspended) through AT commands; 3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  Band8 CH21750 1) The module under test is powered on and successfully registered with the	and successfully registered with the	
(USB is suspended) through AT commands;  3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  Band8 CH21750  1) The module under test is powered on and successfully registered with the	data network;	TBD
commands; 3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  Band8 CH21750 1) The module under test is powered on and successfully registered with the	2) The module is set to sleep state	
3) The module under test remains in the state of no data transmission for 10 minutes, and records Average current for 10 minutes.  Band8 CH21750  1) The module under test is powered on and successfully registered with the	(USB is suspended) through AT	
state of no data transmission for 10 minutes, and records Average current for 10 minutes.  Band8 CH21750  1) The module under test is powered on and successfully registered with the	commands;	
minutes, and records Average current for 10 minutes.  Band8 CH21750  1) The module under test is powered on and successfully registered with the	3) The module under test remains in the	
for 10 minutes.  Band8 CH21750  1) The module under test is powered on and successfully registered with the	state of no data transmission for 10	
Band8 CH21750  1) The module under test is powered on and successfully registered with the	minutes, and records Average current	
The module under test is powered on and successfully registered with the	for 10 minutes.	
and successfully registered with the	Band8 CH21750	
	1) The module under test is powered on	TBD
data network;	and successfully registered with the	
	data network;	



ILICIO		T	T IVIA322 Hardw	are Design Manuai
			2) The module is set to sleep state	
			through AT command (USB is in the	
			suspended state);	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			Band34 CH36275	
			1) The module under test is powered on	
			and successfully registered with the	
			data network;	TBD
			2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	
			state of no data transmission for 10	
		The module is	minutes, and records Average current	
			for 10 minutes.	
			Band34 CH36250	
			1) The module under test is powered on	
	TDD		and successfully registered with the	
		powered on,	data network;	TBD
		pomorou on,	2) The module is set to sleep state	
		registered in	through AT commands (USB is in the	
		the network idle	suspended state);	
		state, the DRX	3) The module under test remains in the	
		monitoring	state of no data transmission for 10	
		period is 1.28s	minutes, and records Average current	
		, no data	for 10 minutes.	
		transmission,	Band34 CH36300	
		and the USB is	1) The module under test is powered on	
		in the	and successfully registered with the	
		suspended	data network;	TBD
		state	2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			Band38 CH38000	
			1) The module under test is powered on	
			and successfully registered with the	TBD
			data network;	
			2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	



	<del> </del>
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band38 CH38250	
The module under test is powered on	
and successfully registered with the	
data network;	
2) The module is set to sleep state	TBD
through AT command (USB is in the	
suspended state);	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band38 CH38300	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
(USB is suspended) through AT	
commands;	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band39 CH38450	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	100
(USB is suspended) through AT	
commands;	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band39 CH38300	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
through AT command (USB is in the	
suspended state);	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	



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Band39 CH38600	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
through AT command (USB is in	
suspended state);	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band40 CH39150	
1) The module under test is powered on	
and successfully registered to the data	
network;	TBD
2) The module is set to sleep state	
(USB is suspended) through AT	
commands;	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band40 CH38700	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
(USB is suspended) through AT	
commands;	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band40 CH39600	
1) The module under test is powered on	
and successfully registered with the	
data network;	TBD
2) The module is set to sleep state	
(USB is suspended) through AT	
commands;	
3) The module under test remains in the	
state of no data transmission for 10	
minutes, and records Average current	
for 10 minutes.	
Band41 CH40620	
1) The module under test is powered on	TBD
and successfully registered with the	
data network;	



ILIO		Τ		are Design Manual
			2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			Band41 CH40290	
			1) The module under test is powered on	
			and successfully registered with the	
			data network;	TBD
			2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			Band41 CH41190	
			1) The module under test is powered on	
			and successfully registered with the	
			data network;	TBD
			2) The module is set to sleep state	
			(USB is suspended) through AT	
			commands;	
			3) The module under test remains in the	
			state of no data transmission for 10	
			minutes, and records Average current	
			for 10 minutes.	
			Band1 CH18300	
			module under test is kept for 10 minutes	TBD
		The module is	without data transmission, and the	
			average current for 10 minutes is	
		powered on	recorded.	
			Band1 CH18050	
	FDD	and registered in the network	module under test is kept for 10 minutes	TBD
		idle state. The	without data transmission, and the	
		DRX	average current for 10 minutes is	
			recorded.	
		monitoring period is 1.28s	Band1 CH118550	
		, no data	module under test is kept for 10 minutes	TBD
		transmission,	without data transmission, and the	
		and the USB is	average current for 10 minutes is	
		and the USB is	recorded.	
		active.	Band3 CH19575	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	



プロン大胆		IVIA322 I Idi	dware Design Manual
		recorded.	
		Band3 CH19250	
		module under test is kept for 10 minutes	TBD
		without data transmission, and the	
		average current for 10 minutes is	
		recorded.	
		Band3 CH19900	
		module under test is kept for 10 minutes	TBD
		without data transmission, and the	
		average current for 10 minutes is	
		recorded.	
		Band5 CH20600	
		module under test is kept for 10 minutes without data transmission, and the	TBD
		average current for 10 minutes is	
		recorded.	
		Band5 CH20450	
		module under test is kept for 10 minutes	
		without data transmission, and the	TBD
		average current for 10 minutes is	
		recorded.	
		Band5 CH20525	
		module under test is kept for 10 minutes	
		without data transmission, and the	TBD
		average current for 10 minutes is	
		recorded.	
		Band8 CH21750	
		module under test is kept for 10 minutes	TBD
		without data transmission, and the	100
		average current for 10 minutes is	
		recorded.	
		Band8 CH21625	
		module under test is kept for 10 minutes	TBD
		without data transmission, and the	
		average current for 10 minutes is	
		recorded.	
		The Band8 CH21500	
		module under test remains in the state	TBD
		of no data transmission for 10 minutes,	
		and the average current for 10 minutes	
		is recorded.	
	The module is	Band34 CH436275	
TDD	powered on,	module under test is kept for 10 minutes	TBD
	registered in	without data transmission, and the	
	the network idle	average current for 10 minutes is	



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		state, the DRX	recorded.	
		monitoring		
		period is 1.28s		
		, no data	Band34 CH36250	
		transmission,	module under test is kept for 10 minutes	TBD
		and the USB is	without data transmission, and the	
		in the	average current for 10 minutes is	
		suspended	recorded.	
		state	Band34 CH36300	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band38 CH38300	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band38 CH37800	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band38 CH38200	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band39 CH38450	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band39 CH38300	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band39 CH38600	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band40 CH39150	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
	•	•		



I ILIO			IVIA922 Hall	dware Design Manual
			recorded.	
			Band40 CH38700	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band40 CH39600	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band41 CH40620	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band41 CH40209	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
			Band41 CH41190	
			module under test is kept for 10 minutes	TBD
			without data transmission, and the	
			average current for 10 minutes is	
			recorded.	
	Real		Keep the data connection and send a	
	network	Unicom/Mobile	256-byte packet every 5 minutes. The	TBD
	data		server returns a 256-byte packet	
	hibernation			
			Band1 0dBm	TDD
			module under test for data transmission	TBD
		1) Indoor room	and hold for 5 minutes, record the	
			average current for 5 minutes	
	FDD	temperature	Band1 10dBm	
		state;	module under test conducts data	TBD
		2) Use DC	transmission and keeps it for 5 minutes,	
		power supply to	and records the average current for 5	
		supply the	minutes Band1 23dBm CH18300	
		module, the	module under test conducts data	
		voltage is set to	transmission and keeps it for 5 minutes,	TBD
		3.8V;	and records the average current for 5	
			minutes	
				TDD
			Band1 23dBm CH18050	TBD



	module under test conducts data	
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band1 23dBm CH18550	
	module under test performs data	TBD
	transmission and keeps it for 5 minutes,	155
	and records the average current for 5	
	minutes	
	Band3 0dBm	
	module under test for data transmission	TBD
	and hold for 5 minutes, record the	
	average current for 5 minutes	
	Band3 10dBm	
	module under test conducts data	TDD
	transmission and keeps it for 5 minutes,	TBD
	and records the average current for 5	
	minutes	
	Band3 23dBm CH19575	
	module under test conducts data	TDD
	transmission and keeps it for 5 minutes,	TBD
	and records the average current for 5	
	minutes	
	Band3 23dBm CH19250	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	IBD
	and records the average current for 5	
	minutes	
	Band3 23dBm CH19900	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	IBD
	and records the average current for 5	
	minutes	
	Band5 0dBm	
	module under test for data transmission	TBD
	and hold for 5 minutes, record the	
	average current for 5 minutes	
	Band5 10dBm	
	module under test conducts data	TDD
	transmission and keeps it for 5 minutes,	TBD
	and records the average current for 5	
	minutes	
	Band5 23dBm CH20525	
	module under test conducts data	TOD
	transmission and keeps it for 5 minutes,	TBD
	and records the average current for 5	
	minutes	
ı	minutes	



Bands 23dBm CH20490 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Bands 23dBm CH20600 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band8 0dBm module under test for data transmission and hold for 5 minutes, record the average current for 5 minutes  Band8 10dBm module under test for data transmission and hold for 5 minutes, record the average current for 5 minutes and records the average current for 5 minutes  Band8 23dBm CH21625 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band8 23dBm CH21600 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band8 23dBm CH217500 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band8 23dBm CH21750 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band34 0dBm module under test for data transmission and hold for 5 minutes, record the average current for 5 minutes, and records the average current for 5 minutes  Band34 0dBm module under test for data transmission and hold for 5 minutes, record the average current for 5 minutes, and records the average current for 5 minutes  Band34 23dBm CH36275 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band34 23dBm CH36275 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band34 23dBm CH36275 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes		MA922 Hardware	Design Manual
transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band\$ 23dBm CH20600 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 6 minutes  Band\$ 0dBm module under test for data transmission and hold for 5 minutes, record the average current for 5 minutes  Band\$ 10dBm module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band\$ 23dBm CH21625 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band\$ 23dBm CH21625 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band\$ 23dBm CH21500 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes, and records the average current for 5 minutes  Band\$ 23dBm CH21750 module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band\$4 0dBm module under test conducts data transmission and hold for 5 minutes, record the average current for 5 minutes  Band\$4 10dBm module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes  Band\$4 10dBm module under test conducts data transmission and keeps it for 5 minutes, and records the average current for 5 minutes, and records the average current for 5 minutes  Band\$4 10dBm and keeps it for 5 minutes, and records the average current for 5		Band5 23dBm CH20450	
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and records the average current for 5	TDD	module under test conducts data	BD
		transmission and keeps it for 5 minutes,	
minutes		and records the average current for 5	
		minutes	



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Band34 23dBm CH36250	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	
and records the average current for 5	
minutes	
Band34 23dBm CH36300	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	
and records the average current for 5	
minutes	
Band38 0dBm	
module under test for data transmission	TBD
and hold for 5 minutes, record the	
average current for 5 minutes	
Band38 10dBm	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	
and records the average current for 5	
minutes	
Band38 23dBm CH38000	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	100
and records the average current for 5	
minutes	
Band38 23dBm CH37800	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	100
and records the average current for 5	
minutes	
Band38 23dBm CH38200	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	100
and records the average current for 5	
minutes	
Band39 0dBm	
module under test for data transmission	TBD
and hold for 5 minutes, record the	
average current for 5 minutes	
Band39 10dBm	
module under test conducts data	TBD
transmission and keeps it for 5 minutes,	טטו
and records the average current for 5	
minutes	
Band39 23dBm CH38450	
module under test performs data	TDD
transmission and keeps it for 5 minutes,	TBD
and records the average current for 5	
minutes	
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	Band39 23dBm CH38300	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band39 23dBm CH38600	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band40 0dBm	
	module under test for data transmission	TBD
	and hold for 5 minutes, record the	
	average current for 5 minutes	
	Band40 10dBm	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band40 23dBm CH39150	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	155
	and records the average current for 5	
	minutes	
	Band40 23dBm CH38700	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band40 23dBm CH39600	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band41 0dBm	
	module under test for data transmission	TBD
	and hold for 5 minutes, record the	
	average current for 5 minutes	
	Band41 10dBm	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	-
	and records the average current for 5	
	minutes	
	Band41 23dBm CH40620	
	module under test conducts data	TBD
	transmission and keeps it for 5 minutes,	.55
	and records the average current for 5	
	minutes	
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	Band41 23dBm CH40290	
	module under test performs data	TBD
	transmission and keeps it for 5 minutes,	
	and records the average current for 5	
	minutes	
	Band41 23dBm CH41190	
	module under test performs data	TBD
	transmission and keeps it for 5 minutes,	,
	and records the average current for 5	
	minutes	
	n41A CH509202 @ 23. 30 dBm	
	n41A CH518598 @ 23.49 dBm	
	n41A CH528000 @ 23.42 dBm	
	n77A CH623334 @ 26.01 dBm	
	n77A CH650000 @ 26.06 dBm	
	n77A CH676666 @ 26.00 dBm	
5G SA	n78A CH623334 @ 25.97 dBm	
JG SA	n78A CH636666 @ 25.99 dBm	TBD
	n78A CH650000 @ 26.21 dBm	
	n1A CH426000 @ 23.05 dBm	
	n1A CH428000 @ 23.29 dBm	
	n1A CH430000 @ 23.33 dBm	
	n3A CH364000 @ 23.30 dBm	
	n3A CH368500 @ 23.26 dBm	
	n3A CH373000 @ 23.08 dBm	
	n8A CH364000 @ 23.30 dBm	
	n8A CH368500 @ 23.26 dBm	
	n8A CH373000 @ 23.08 dBm	
	n28A CH154600 @ 22.99 dBm	
	The module under test transmits data	
	and holds it for 5 minutes, recording the	
	average current for 5 minutes	
	1A_n78A CH623334 @ 22.85 dBm	
	1A_n78A CH636666 @ 22.85 dBm	
	1A_n78A CH650000 @ 22.78 dBm	
	3A_n78A CH623334 @ 25.71 dBm	
EC NOA	3A_n78A CH636666 @ 25.67 dBm	
5G NSA	3A_n78A CH650000 @ 25.60 dBm	TBD
	5A_n78A CH623334 @ 22.98 dBm	
	5A_n78A CH636666 @ 22.56 dBm	
	5A_n78A CH650000 @ 22.95 dBm	
	7A_n78A CH623334 @ 23.07 dBm	
	7A_n78A CH636666 @ 22.94 dBm	
	7A_n78A CH650000 @ 23.09 dBm	
	8A_n78A CH623334 @ 22.92 dBm	
	8A_n78A CH636666 @ 22.51 dBm	
	8A_n78A CH650000 @ 22.91 dBm	
	38A_n78A CH623334 @ 23.17 dBm	
	1	

MLIU 美胎	MA922 Hardware Design Manual
	38A_n78A CH636666 @ 23.15 dBm
	38A_n78A CH650000 @ 23.23 dBm
	40A_n78A CH623334 @ 22.97 dBm
	40A_n78A CH636666 @ 22.94 dBm
	40A_n78A CH650000 @ 23.06 dBm
	1A_n77A CH623334 @ 22.90 dBm
	1A_n77A CH650000 @ 22.80 dBm
	1A_n77A CH676666 @ 22.92 dBm
	3A_n77A CH623334 @ 25.75 dBm
	3A_n77A CH650000 @ 25.68 dBm
	3A_n77A CH676666 @ 25.68 dBm
h h	5A_n77A CH623334 @ 22.98 dBm
	5A_n77A CH650000 @ 23.03 dBm
	5A_n77A CH676666 @ 22.99 dBm
	7A_n77A CH623334 @ 23.08 dBm
	7A_n77A CH650000 @ 23.04 dBm
	7A_n77A CH676666 @ 23.15 dBm
	8A_n77A CH623334 @ 22.87 dBm
	8A_n77A CH650000 @ 23.02 dBm
	8A_n77A CH676666 @ 23.08 dBm
	The module under test transmits data
	and holds it for 5 minutes, recording the
	average current for 5 minutes

### 5.4 ESD Characteristics

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The module is not specifically protected against electrostatic discharge. Therefore, users must pay attention to electrostatic protection when producing, assembling and operating modules. Refer to the table below for .



# 6. Mechanical Characteristics

This chapter describes the mechanical dimensions of the module, all dimensions are in millimeters, and all dimensions without tolerances are ±0.05mm.

#### **6.1 Module Mechanical Dimensions**

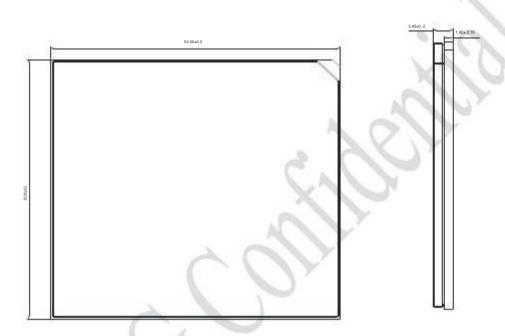


Figure 39 Top view and side view dimension drawing (unit: mm)

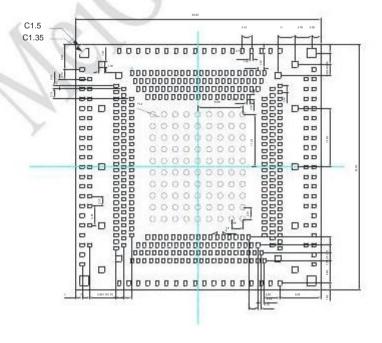
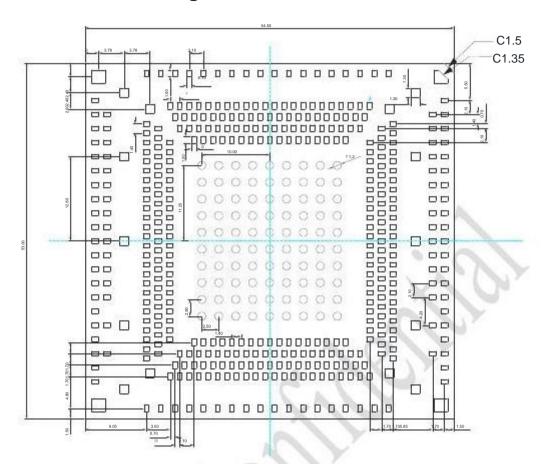


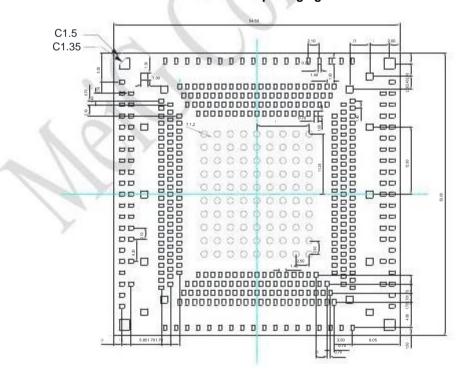
Figure 40 Bottom view dimension drawing (unit: mm)



#### 6.2 Recommended Package



#### a. Recommended packaging



b. Recommended packaging

Figure 41 Recommended package (top view) (unit: mm)



# **6.3 Module Top View**



Figure 42 Module top view

### **6.4 Module Bottom View**

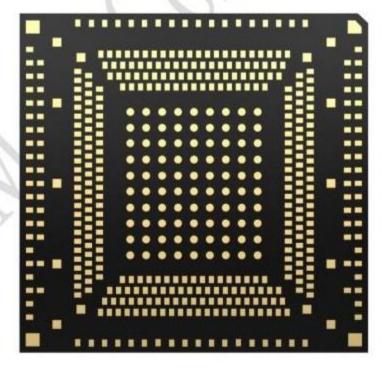


Figure 43 Bottom view of the module



# 7. Storage and Production

#### 7.1 Storage

The MA922 ships in a vacuum-sealed bag. The storage of modules must comply with the following conditions:

- 1. When the ambient temperature is lower than 40 degrees Celsius and the air humidity is lower than 90%, the module can be stored in a vacuum-sealed bag for 12 months;
- 2. After the vacuum-sealed bag is opened, the module can be directly reflowed or other high-temperature processes if the following conditions are met:
  - ☐ Module storage air humidity is less than 10%;
- The ambient temperature of the module is lower than 30 degrees Celsius, the air humidity is less than 60%, and the factory can complete the patch within 72 hours.
- 3. If the module is under the following conditions, it needs to be baked before placement:
- When the ambient temperature is 23 degrees Celsius (the fluctuation of 5 degrees Celsius is allowed), the humidity displayed by the humidity indicator card is greater than 10%;
- Uhen the vacuum seal bag is opened, the ambient temperature of the module is lower than 30 degrees Celsius, and the air humidity is less than 60%, but the factory failed to complete the patch within 168 hours;
- When the vacuum-sealed bag is opened, the module storage air humidity is greater than 10%.
- 4. bake it for 8 hours at 125°C (allow 5°C fluctuations up and down).

#### Remarks

The mod's packaging cannot withstand such high temperatures, please remove the mod's packaging before the mod is baked.





Figure 44 Reflow Soldering Temperature Curve



# 7.3 Package

The MA922 is packaged in a tray. The packaging size of the tray is 310\*200\*20mm ( \*\*PCS ) and placed as follows:

Figure 45 Pallet Packaging(undetermined)





# 8. Appendix A Reference Documents and Term Abbreviations

#### **8.1 Reference Document**

- ☐ MA922 module specifications;
- □ MA922 AT command set;
- MA922 EVB User Manual;
- ☐ MA922 reference design circuit;
- MA922 Application Business Process Manual.

#### 8.2 Term Abbreviation

Table 34 Abbreviations of terms

Abbreviation	English description	Chinese description
AMR	Adaptive Multi-rate	自适应多速率
BER	Bit Error Rate	误码率
BTS	Base Transceiver Station	基站收发信台
PCI	Peripheral Component Interconnect	外设部件互连
CS	Circuit Switched (CS) domain	电路域
CSD	Circuit Switched Data	电路交换数据
DCE	Data communication equipment	数据电路终端设备
DTE	Data terminal equipment	数据终端设备
DTR	Data Terminal Ready	数据终端就绪
EDGE	Enhanced Data rates for GSM Evolution	增强型GPRS
EFR	Enhanced Full Rate	增强型全速率
EGSM	Enhanced GSM	增强型GSM
EMC	Electromagnetic Compatibility	电磁兼容性
ESD	Electrostatic Discharge	静电释放
FR	Frame Relay	帧中继
GMSK	Gaussian Minimum Shift Keying	高斯最小移频键控
GPIO	General Purpose Input Output	通用输入/输出
GPRS	General Packet Radio Service	通用分组无线系统
GSM	Global Standard for Mobile Communications	全球标准移动通信系统
HR	Half Rate	半速
HSDPA	High Speed Downlink Packet Access	高速下行分组接入
HSUPA	High Speed Uplink Packet Access	高速上行分组接入
HSPA	HSPA High-Speed Packet Access	高速分组接入
HSPA+	HSPA High-Speed Packet Access+	增强型高速分组接入



		MAJZZ Haldware Design W
IEC	International Electro-technical Commission	国际电工技术委员会
IMEI	International Mobile Equipment Identity	国际移动设备标识
MEID	Mobile Equipment Identifier	CDMA终端的身份识别码
I/O	Input/Output	输入/输出
ISO	International Standards Organization	国际标准化组织
ITU	International Telecommunications Union	国际电信联盟
bps	bits per second	比特每秒
led	Light Emitting Diode	发光二极管
M2M	Machine to machine	机器到机器
MO	Mobile Originated	移动台发起的
MT	Mobile Terminated	移动台终止的
NTC	Negative Temperature Coefficient	负温度系数
PC	Personal Computer	个人计算机
PCB	Printed Circuit Board	印制电路板
PCS	Personal Cellular System	个人蜂窝系统
PCM	Pulse Code Modulation	脉冲编码调制
PCS	Personal Communication System	GSM1900
PDU	Packet Data Unit	 分组数据单元
PPP	Point-to-point protocol	点到点协议
PS	Packet Switched	
QPSK	Quadrate Phase Shift Keying	正交相位移频键控
SIM	Subscriber Identity Module	用户识别模组
TCP/IP	Transmission Control Protocol/ Internet Protocol	
UART	Universal asynchronous receiver-transmitter	通用异步收/发器(机)
USIM	Universal Subscriber Identity Module	通用用户识别模组
UMTS	Universal Mobile Telecommunications System	通用移动通信系统
USB	Universal Serial Bus	通用串行总线
WCDMA	Wideband Code Division Multiple Access	宽带码分多址
· · · · · · · · · · · · · · · · · · ·	Time Division-Synchronous Code Division Multiple	
TD-SCDMA	Access	时分同步码分多址
TDD-LTE	Time Division Long Term Evolution	   时分长期演进
FDD-LTE	Frequency Division Duplexing Long Term Evolution	频分长期演进
Vmax	Maximum Voltage Value	最大电压值
Vnorm	Normal Voltage Value	典型电压值
Vmin	Minimum Voltage Value	最小电压值
V н max	Maximum Input High Level Voltage Value	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
V Iн min	Minimum Input High Level Voltage Value	输入高电平的最小电压
		输入低电平的最大电压
V ⊩ max	Maximum Input Low Level Voltage Value	输入低电平的最小电压
V ⊩ min	Minimum Input Low Level Voltage Value	物出高电平的最大电压
V он max	Maximum Output High Level Voltage Value	输出高电平的最小电压
VOH min_	Minimum Output High Level Voltage Value	
V ol max	Maximum Output Low Level Voltage Value	<b>输出低电平的最大电压</b>
VOL min_	Minimum Output Low Level Voltage Value	输出低电平的最小电压